



[CF 4000

Write Protect

Customer:	
Customer	
Part Number:	
InnoDisk	
Part Number:	
InnoDisk	
Model Name:	
Date:	

InnoDisk	Customer
Approver	Approver



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REVISION HISTORY

Revision	Description	Date
1.0	Release First Version	Mar. 2011



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Rev 1.0



1. Introduction

The InnoDisk Industrial CompactFlash® 4000 Memory Card (iCF4000) products provide high capacity solid-state flash memory that electrically complies with the Personal Computer Memory Card International Association (PCMCIA) ATA (PC Card ATA) standard. (In Japan, the applicable standards group is JEIDA.) The CompactFlash® and PCMCIA cards support True IDE Mode that is electrically compatible with an IDE disk drive. The original CF form factor card can be used in any system that has a CF slot. Designed to replace traditional rotating disk drives, InnoDisk Industrial CompactFlash® 4000 Memory Cards are embedded solid-state data storage systems for mobile computing and the industrial work place. The Industrial CompactFlash® features an extremely lightweight, reliable, low-profile form factor.

Industrial CompactFlash® 4000 (iCF4000) supports advanced PIO (0-6), Multiword DMA (0-4), Ultra DMA (0-4) transfer modes, multi-sector transfers, and LBA addressing.

2. Features

The Industrial ATA products provide the following system features:

- Capacities: 128MB~32GB
- Fully compatible with CompactFlash® specification version 3.0
- Fully compatible with PC Card Standard.
- Fully compatible with the IDE standard interface, ATA Standard
- Three access modes
 - PC Card Memory Mode
 - PC Card I/O Mode
 - True IDE Mode
- ECC (Error Correction Code) function: 4 bits/ per 512 byte
- +3.3V/+5V single power supply operation
- Support Auto Stand-by and Sleep Mode.
- Power Consumption
- Single



◆ 5V

Active mode

Read operation: 69mA(Typ.)

Write operation: 59mA(Typ.)

Power Down mode: 1.2mA(Typ./max.)

◆ 3.3V

Active mode

Read operation: 67mA(Typ.)

Write operation: 52mA(Typ.)

Power Down mode: 0.7mA(Typ./max.)

Dual

♦ 5V

Active mode

Read operation: 125mA(Typ.)

Write operation: 120mA(Typ.)

Power Down mode: 1.3mA(Typ./max.)

♦ 3.3V

Active mode

Read operation: 121mA(Typ.)

Write operation: 115mA(Typ.)

Power Down mode: 0.6mA(Typ.), 0.7(max.)

• Support transfer modes: PIO(0-6), Multiword DMA (0-4) and Ultra DMA(0-4)

Rev 1.0

- MTBF 3,000,000 hours
- Endurance: 2,000,000 Program/Erase Cycles
- · Data retention: 10 years
- R/W performance:

-Single: 128MB~2GB

Read: 20Mbytes/s. (MAX)

Write: 10Mbytes/s (MAX)

-Dual:

1GB~8GB

◆ Read: 40Mbytes/s. (MAX)

Write: 20Mbytes/s (MAX)



• 16GB~32GB

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Read: 40mbytes/s. (MAX)

♦ Write: 28Mbytes/s. (MAX)

• Operating temperature range:

- Standard Grade: 0°C ~ +70°C

- Industrial Grade: -40°C ~ +85°C

• Storage temperature range: -55°C ~ +95°C



3. Pin Assignment

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See Table 1 for iCF4000 pin assignments.

Table 1: iCF4000 Pin Assignments

PC Card Memory Mode			PC Ca	ard I/O Mode	е	True I	True IDE Mode		
Pin	N I	1/0	Pin		1/0	Pin	N	1/0	
No.	Name	I/O	No.	Name	I/O	No.	Name	I/O	
1	GND		1	GND		1	GND		
2	D03	I/O	2	D03	I/O	2	D03	I/O	
3	D04	I/O	3	D04	I/O	3	D04	I/O	
4	D05	I/O	4	D05	I/O	4	D05	I/O	
5	D06	I/O	5	D06	I/O	5	D06	I/O	
6	D07	I/O	6	D07	I/O	6	D07	I/O	
7	-CE1	I	7	-CE1	1	7	-CS0	I	
8	A10	I	8	A10	I	8	A10 ²	I	
9	-OE	I	9	-OE	I	9	-ATA SEL	I	
10	A09	I	10	A09	I	10	A09 ²	I	
11	A08	I	11	A08	I	11	A08 ²	I	
12	A07	I	12	A07	I	12	A07 ²	I	
13	VCC		13	VCC		13	VCC		
14	A06	I	14	A06	I	14	A06 ²	I	
15	A05	I	15	A05	I	15	A05 ²	I	
16	A04	I	16	A04	1	16	A04 ²	I	
17	A03	I	17	A03	1	17	A03 ²	I	
18	A02	I	18	A02	I	18	A02	I	
19	A01	I	19	A01	I	19	A01	I	
20	A00	I	20	A00	I	20	A00	I	
21	D00	I/O	21	D00	I/O	21	D00	I/O	
22	D01	I/O	22	D01	I/O	22	D01	I/O	
23	D02	I/O	23	D02	I/O	23	D02	I/O	
24	WP	0	24	-IOIS16	0	24	-IOCS16	0	
25	-CD2	0	25	-CD2	0	25	-CD2	0	
26	-CD1	0	26	-CD1	0	26	-CD1	0	
27	D11 ¹	I/O	27	D11 ¹	I/O	27	D11 ¹	I/O	
28	D12 ¹	I/O	28	D12 ¹	I/O	28	D12 ¹	I/O	
29	D13 ¹	I/O	29	D13 ¹	I/O	29	D13 ¹	I/O	
30	D14 ¹	I/O	30	D14 ¹	I/O	30	D14 ¹	I/O	



31	D15 ¹	I/O	31	D15 ¹	I/O	31	D15 ¹	I/O
32	-CE2 ¹	I	32	-CE2 ¹	I	32	-CS1 ¹	I
33	-VS1	0	33	-VS1	0	33	-VS1	0
							-IORD ⁷	
34	-IORD	1	34	-IORD	1	34	HSTROBE ⁸	I
							-HDMARDY ⁹	
35	-IOWR	1	35	-IOWR	1	35	-IOWR ⁷	ı
33	-IOVVK	1	33	-IOVK	-	33	STOP ^{8, 9}	•
36	-WE	I	36	-WE	I	36	-WE ³	I
37	READY	0	37	-IREQ	0	37	INTRQ	0
38	VCC		38	VCC		38	VCC	
39	-CSEL ⁵	I	39	-CSEL ⁵	I	39	-CSEL	I
40	-VS2	0	40	-VS2	0	40	-VS2	0
41	RESET	I	41	RESET	I	41	-RESET	I
							IORDY ¹	
42	-WAIT	0	42	-WAIT	0	42	-DDMARDY ⁸	0
							DSTROBE ⁹	
43	-INPACK	0	43	-INPACK	0	43	DMARQ	0
44	-REG	I	44	-REG	I	44	-DMACK ⁶	I
45	BVD2	0	45	-SPKR	0	45	-DASP	I/O
46	BVD1	0	46	-STSCHG	0	46	-PDIAG	I/O
47	D08 ¹	I/O	47	D08 ¹	I/O	47	D08 ¹	I/O
48	D09 ¹	I/O	48	D09 ¹	I/O	48	D09 ¹	I/O
49	D10 ¹	I/O	49	D10 ¹	I/O	49	D10 ¹	I/O
50	GND		50	GND		50	GND	

Note:

- 1) These signals are required only for 16 bit accesses and not required when installed in 8 bit systems. Devices should allow for 3-state signals not to consume current.
- 2) The signal should be grounded by the host.
- 3) The signal should be tied to VCC by the host.
- 4) The mode is optional for CF+ Cards, but required for CompactFlash® Storage Cards.
- The -CSEL signal is ignored by the card in PC Card modes. However, because it is not pulled up on the card in these modes, it should not be left floating by the host in PC Card modes. In these modes, the pin should be connected by the host to PC Card A25 or grounded by the host.
- 6) If DMA operations are not used, the signal should be held high or tied to VCC by the host. For proper operation in older hosts: while DMA operations are not active, the card shall



ignore this signal, including a floating condition

- 7) Signal usage in True IDE Mode except when Ultra DMA mode protocol is active.
- 8) Signal usage in True IDE Mode when Ultra DMA mode protocol DMA Write is active.
- 9) Signal usage in True IDE Mode when Ultra DMA mode protocol DMA Read is active.



4. Pin Description

Table 2 describes the pin descriptions for iCF4000

Table 2: iCF4000 Pin Description

Pin No.	Pin Name	I/O	Mode	Description
8,10,11, 12,14,15 16,17,18 19, 20	12,14,15 16,17,18 A10 – A0 PC Ca Memory Mode		PC Card Memory Mode	These address lines along with the -REG signal are used to select the following: The I/O port address registers within the CompactFlash® Storage Card or CF+ Card, the memory mapped port address registers within the CompactFlash® Storage Card or CF+ Card, a byte in the card's information structure and its configuration control and status registers.
8,10,11, 12,14,15 16,17,18 19, 20	A10 – A0	1	PC Card I/O Mode	This signal is the same as the PC Card Memory Mode signal.
18,19,20	A2 – A0		True IDE Mode	In True IDE Mode, only A[2:0] are used to select the one of eight registers in the Task File, the remaining address lines should be grounded by the host.
	BVD1	I/O	PC Card Memory Mode	This signal is asserted high, as BVD1 is not supported.
46	-STSCHG		PC Card I/O Mode	This signal is asserted low to alert the host to changes in the READY and Write Protect states, while the I/O interface is configured. Its use is controlled by the Card configuration and Status Register.
	-PDIAG		True IDE Mode	In the True IDE Mode, this input / output is the Pass Diagnostic signal in the Master / Slave handshake protocol.
	BVD2		PC Card Memory Mode	This signal is asserted high, as BVD2 is not supported.
45	-SPKR	I/O	PC Card I/O Mode	This line is the Binary Audio output from the card. If the Card does not support the Binary Audio function, this line should be held negated.
	-DASP		True IDE Mode	In the True IDE Mode, this input/output is the Disk Active/Slave Present signal in the Master/Slave



				handahaka pratasal
				handshake protocol.
			PC Card	These Card Detect pins are connected to ground on the
			Memory	CompactFlash® Storage Card or CF+ Card. They are used
			Mode	by the host to determine that the CompactFlash® Storage
26, 25	-CD1, -CD2	0		Card or CF+ Card is fully inserted into its socket.
20, 20	051, 052		PC Card	This signal is the same for all modes.
			I/O Mode	This dignario the same for all modes.
			True IDE Mode	This signal is the same for all modes.
				These input signals are used both to select the card and to
				indicate to the card whether a byte or a word operation is
			PC Card	being performedCE2 always accesses the odd byte of
	-CE1, -CE2		Memory	the wordCE1 accesses the even byte or the Odd byte of
			Mode	the word depending on A0 and -CE2. A multiplexing
				scheme based on A0, -CE1, -CE2 allows 8 bit hosts to
7 00				access all data on D0-D7.
7, 32	054 050	I	PC Card	This signal is the same as the PC Card Memory Mode
	-CE1, -CE2		I/O Mode	signal.
	-CS0, -CS1		True IDE Mode	In the True IDE Mode, -CS0 is the chip select for the task
				file registers while -CS1 is used to select the Alternate
				Status Register and the Device Control Register.
				While -DMACK is asserted, -CS0 and -CS1 shall be held
				negated and the width of the transfers shall be 16 bits.
			PC Card	This signal is not used for this mode, but should be
			Memory	connected by the host to PC Card A25 or grounded by the
			Mode	host.
			PC Card	This signal is not used for this mode, but should be
			I/O Mode	connected by the host to PC Card A25 or grounded by the
39	-CSEL	I	., ooao	host.
				This internally pulled up signal is used to configure this
			True IDE	device as a Master or a Slave when configured in the True
			Mode	IDE Mode. When this pin is grounded, this device is
				configured as a Master. When the pin is open, this device
				is configured as a Slave.
2,3,4,5,6			PC Card	These lines carry the Data, Commands and Status
31,30,29	D15 - D00	I/O	Memory	information between the host and the controller. D00 is the
28,27,49			Mode	LSB of the Even Byte of the Word. D08 is the LSB of the
48,47,23				Odd Byte of the Word.



22,21			PC Card	This signal is the same as the PC Card Memory Mode		
			I/O Mode	signal.		
		True IDE		In True IDE Mode, all Task File operations occur in byte		
			Mode	mode on the low order bus D[7:0] while all data transfers		
			Wiodo	are 16 bit using D[15:0].		
			PC Card			
			Memory	Ground.		
1, 50 GND			Mode			
	GND	-	PC Card	This signal is the approx for all sounds.		
			I/O Mode	This signal is the same for all modes.		
			True IDE			
			Mode	This signal is the same for all modes.		
			PC Card			
	-INPACK		Memory	This signal is not used in this mode.		
			Mode			
				The Input Acknowledge signal is asserted by the		
		NPACK		CompactFlash [®] Storage Card or CF+ Card when the card		
				is selected and responding to an I/O read cycle at the		
	-INPACK		PC Card I/O Mode	address that is on the address bus. This signal is used by		
				the host to control the enable of any input data buffers		
				between the CompactFlash [®] Storage Card or CF+ Card		
				and the CPU.		
				This signal is a DMA Request that is used for DMA data		
				transfers between host and device. It shall be asserted by		
				the device when it is ready to transfer data to or from the		
43		0		host. For Multiword DMA transfers, the direction of data		
				transfer is controlled by -IORD and -IOWR. This signal is		
				used in a handshake manner with -DMACK, i.e., the		
			True IDE	device shall wait until the host asserts -DMACK before		
	DMARQ			negating DMARQ, and reasserting DMARQ if there is		
			Mode	more data to transfer. DMARQ shall not be driven when		
				the device is not selected. While a DMA operation is in		
				progress, -CS0 and -CS1 shall be held negated and the		
				width of the transfers shall be 16 bits. If there is no		
				hardware support for DMA mode in the host, this output		
				signal is not used and should not be connected at the host.		
				In this case, the BIOS must report that DMA mode is not		
				supported by the host so that device drivers will not		



		ı	<u> </u>	•
			PC Card	attempt DMA mode. A host that does not support DMA mode and implements both PCMCIA and True-IDE modes of operation need not alter the PCMCIA mode connections while in True-IDE mode as long as this does not prevent proper operation in any mode.
			Memory Mode	This signal is not used in this mode.
	-IORD		PC Card I/O Mode	This is an I/O Read strobe generated by the host. This signal gates I/O data onto the bus from the CompactFlash® Storage Card or CF+ Card when the card is configured to use the I/O interface.
	-IORD			In True IDE Mode, while Ultra DMA mode is not active, this signal has the same function as in PC Card I/O Mode.
34	-HDMARDY	I	True IDE	In True IDE Mode when Ultra DMA mode DMA Read is active, this signal is asserted by the host to indicate that the host is read to receive Ultra DMA data-in bursts. The host may negate -HDMARDY to pause an Ultra DMA transfer.
	HSTROBE		Mode	In True IDE Mode when Ultra DMA mode DMA Write is active, this signal is the data out strobe generated by the host. Both the rising and falling edge of HSTROBE cause data to be latched by the device. The host may stop generating HSTROBE edges to pause an Ultra DMA data-out burst.
	-IOWR		PC Card Memory Mode	This signal is not used in this mode.
35	-IOWR	I DWR	PC Card I/O Mode	The I/O Write strobe pulse is used to clock I/O data on the Card Data bus into the CompactFlash® Storage Card or CF+ Card controller registers when the CompactFlash® Storage Card or CF+ Card is configured to use the I/O interface. The clocking shall occur on the negative to positive edge of the signal (trailing edge).



	-IOWR		True IDE Mode	In True IDE Mode, while Ultra DMA mode protocol is not active, this signal has the same function as in PC Card I/O Mode. When Ultra DMA mode protocol is supported, this signal must be negated before entering Ultra DMA mode protocol. In True IDE Mode, while Ultra DMA mode protocol is active, the assertion of this signal causes the termination of the Ultra DMA burst.		
9	-OE	. 1	PC Card Memory Mode	This is an Output Enable strobe generated by the host interface. It is used to read data from the CompactFlash® Storage Card or CF+ Card in Memory Mode and to read the CIS and configuration registers.		
	-OE -ATA SEL		PC Card I/O Mode	In PC Card I/O Mode, this signal is used to read the CIS and configuration registers.		
			True IDE Mode	To enable True IDE Mode this input should be grounded by the host.		
37	READY	0	PC Card Memory Mode	In Memory Mode, this signal is set high when the CompactFlash® Storage Card or CF+ Card is ready to accept a new data transfer operation and is held low when the card is busy. At power up and at Reset, the READY signal is held low (busy) until the CompactFlash® Storage Card or CF+ Card has completed its power up or reset function. No access of any type should be made to the CompactFlash® Storage Card or CF+ Card during this time. Note, however, that when a card is powered up and used with RESET continuously disconnected or asserted, the Reset function of the RESET pin is disabled. Consequently, the continuous assertion of RESET from the application of power shall not cause the READY signal to remain continuously in the busy state.		
	-IREQ		PC Card I/O Mode	I/O Operation – After the CompactFlash® Storage Card or CF+ Card has been configured for I/O operation, this signal is used as -Interrupt Request. This line is strobed low to generate a pulse mode interrupt or held low for a level mode interrupt.		
	INTRQ		True IDE Mode	In True IDE Mode signal is the active high Interrupt Request to the host.		



44	-REG		PC Card Memory Mode PC Card I/O Mode	This signal is used during Memory Cycles to distinguish between Common Memory and Register (Attribute) Memory accesses. High for Common Memory, Low for Attribute Memory. The signal shall also be active (low) during I/O Cycles when the I/O address is on the Bus. This is a DMA Acknowledge signal that is asserted by the host in response to DMARQ to initiate DMA transfers. While DMA operations are not active, the card shall ignore the -DMACK signal, including a floating condition. If DMA operation is not supported by a True IDE Mode only host,
	-DMACK		True IDE Mode	this signal should be driven high or connected to VCC by the host. A host that does not support DMA mode and implements both PCMCIA and True-IDE modes of operation need not alter the PCMCIA mode connections while in True-IDE mode as long as this does not prevent proper operation all modes.
41	RESET PC Card I/O Mode True IDE		Memory	The CompactFlash® Storage Card or CF+ Card is Reset when the RESET pin is high with the following important exception: The host may leave the RESET pin open or keep it continually high from the application of power without causing a continuous Reset of the card. Under either of these conditions, the card shall emerge from power-up having completed an initial Reset. The CompactFlash® Storage Card or CF+ Card is also Reset when the Soft Reset bit in the Card Configuration Option Register is set.
				This signal is the same as the PC Card Memory Mode signal.
			True IDE Mode	In the True IDE Mode, this input pin is the active low hardware reset from the host.
13, 38	VCC	-	PC Card Memory Mode	+5 V, +3.3 V power.
			PC Card I/O Mode	This signal is the same for all modes.



		1	1	T
			True IDE Mode	This signal is the same for all modes.
33, 40	-VS1, -VS2	0	PC Card Memory Mode PC Card I/O Mode True IDE	Voltage Sense SignalsVS1 is grounded on the Card and sensed by the Host so that the CompactFlash® Storage Card or CF+ Card CIS can be read at 3.3 volts and -VS2 is reserved by PCMCIA for a secondary voltage and is not connected on the Card. This signal is the same for all modes.
			Mode PC Card	The -WAIT signal is driven low by the CompactFlash®
	-WAIT		Memory Mode	Storage Card or CF+ Card to signal the host to delay completion of a memory or I/O cycle that is in progress.
	-WAIT		PC Card I/O Mode	This signal is the same as the PC Card Memory Mode signal.
	IORDY		True IDE Mode	In True IDE Mode, except in Ultra DMA modes, this output signal may be used as IORDY.
42	-DDMARDY	0		In True IDE Mode, when Ultra DMA mode DMA Write is active, this signal is asserted by the host to indicate that the device is read to receive Ultra DMA data-in bursts. The device may negate -DDMARDY to pause an Ultra DMA transfer.
	DSTROBE			In True IDE Mode, when Ultra DMA mode DMA Write is active, this signal is the data out strobe generated by the device. Both the rising and falling edge of DSTROBE cause data to be latched by the host. The device may stop generating DSTROBE edges to pause an Ultra DMA data-out burst.
36	-WE I PC Car I/O Mode True ID		PC Card Memory Mode PC Card I/O Mode True IDE Mode	This is a signal driven by the host and used for strobing memory write data to the registers of the CompactFlash® Storage Card or CF+ Card when the card is configured in the memory interface mode. It is also used for writing the configuration registers. In PC Card I/O Mode, this signal is used for writing the configuration registers. In True IDE Mode, this input signal is not used and should be connected to VCC by the host.



	WP		PC Card Memory Mode	Memory Mode – The CompactFlash® Storage Card or CF+ Card does not have a write protect switch. This signal is held low after the completion of the reset initialization sequence.
24	-IOCS16		PC Card I/O Mode	I/O Operation – When the CompactFlash® Storage Card or CF+ Card is configured for I/O Operation Pin 24 is used for the -I/O Selected is 16 Bit Port (-IOIS16) function. A Low signal indicates that a 16 bit or odd byte only operation can be performed at the addressed port.
			True IDE Mode	In True IDE Mode this output signal is asserted low when this device is expecting a word data transfer cycle.



5. Specifications

5.1 CE Compatibility

iCF4000 conforms to CE requirements.

5.2 RoHS Compliance

iCF4000 is fully compliant with RoHS directive.

5.3 Write Protect Function Support

InnoDisk CF card within the write-protect function could prevent the CF card from modification and deletion. Write-protected data in CF card could only be read, that is, users could not write to it, edit it, append data to it, or delete it.

When users would like to make sure that neither themselves nor others could modify or destroy the file, users could switch on write-protection. Thus InnoDisk CF card would process write-protect mechanism and disable flash memory to be written-in any data. Only while the system power-off, users could switch on write-protection. Write-protection could not be switched-on, after OS booting.

5.4 Environmental Specifications

5.4.1 Temperature Ranges

Operating Temperature Range:

- Standard Grade: 0°C to +70°C

- Industrial Grade: -40°C to +85°C

Storage Temperature Range: -55°C to +95°C

5.4.2 Humidity

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Relative Humidity: 10-95%, non-condensing

5.4.3 Shock and Vibration

Table 3: Shock/Vibration Test for iCF4000

Reliability	Reference Standards		
Vibration	7 Hz to 2 KHz, 5 g, 3 axes	IEC 68-2-6	
Mechanical Shock	Duration: 10ms, 50 g, 3	IEC 68-2-27	
I Wednamoar Oncor	axes		



5.4.4 Mean Time between Failures (MTBF)

Table 4 summarizes the MTBF prediction results for various iCF4000 configurations. The analysis was performed using a RAM Commander $^{\text{TM}}$ failure rate prediction.

- **Failure Rate**: The total number of failures within an item population, divided by the total number of life units expended by that population, during a particular measurement interval under stated condition.
- Mean Time between Failures (MTBF): A basic measure of reliability for repairable items: The mean number of life units during which all parts of the item perform within their specified limits, during a particular measurement interval under stated conditions.

Table 4: iCF40000 MTBF

Product	Condition	MTBF (Hours)
iCF4000	Telcordia SR-332 GB, 25°C	3,000,000

5.5 Error Detection and Correction

Highly sophisticated Error Correction Code algorithms are implemented. The ECC unit consists of the Parity Unit (parity-byte generation) and the Syndrome Unit (syndrome-byte computation). This unit implements a algorithm that can correct 4 bits per 512 bytes in an ECC block. Code-byte generation during write operations, as well as error detection during read operation, is implemented on the fly without any speed penalties.

5.6 Wear-Leveling

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Flash memory can be erased a limited number of times. This number is called the **erase cycle limit** or **write endurance limit** and is defined by the flash array vendor. The erase cycle limit applies to each individual erase block in the flash device.

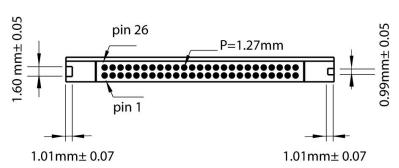
iCF4000 uses a wear-leveling algorithm to ensure that consecutive writes of a specific sector are not written physically to the same page in the flash. This spreads flash media usage evenly across all pages, thereby maximizing flash lifetime.

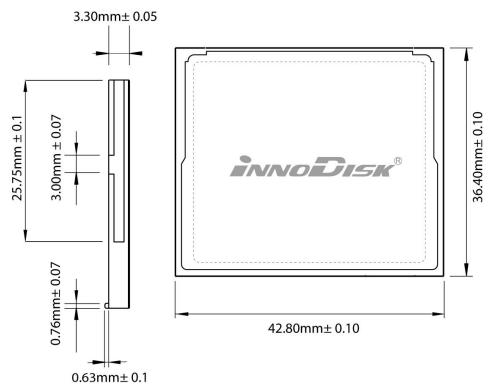


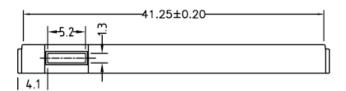
5.7 Mechanical Dimensions

Mechanical Dimension: 42.80±0.1/36.40±0.1/3.30±0.05mm (W/T/H)

Figure 1: Mechanical Dimension of iCF4000







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5.8 Electrical Specifications

5.8.1 Absolute Maximum Ratings

Table 5: iCF4000 Maximum Absolute Ratings

Item	Symbol	Rating	Unit
DC Power Supply	V _{DD} - V _{SS}	-0.3 ~ +5.5	V
Input voltage	V _{IN}	V_{SS} -0.3 ~ V_{DD} +0.3	V
Output voltage	V _{OUT}	V_{SS} -0.3 ~ V_{DD} +0.3	V
Operating	т	Commercial: 0 ~ +70	°C
Temperature	T _A	Industrial: -40 ~ +85	°C
Storage	т	Commercial: -55~ +95	°C
Temperature	T _{ST}	Industrial: -55~ +95	°C

Table 6: Schmitt Trigger Pin

Pin Name	IOL (mA)	Dir				
PinHOE, PinHWE,	10		CMOS	Level	Pull-up	75K
PinHIOR, PinHIOW	12	I	(SCHMITT)			
Innut valtage	40		CMOS	Level	Pull-up	75K
Input voltage	12	I	(SCHMI	ΓΤ)		
Output voltage	12	I	CMOS Level (SCHMITT)			

5.8.2 DC Characteristic

Table 7: iCF4000 DC Characteristic

lt a ma	Cymphol	Value	l loit		
Item	Symbol	Min	Standard	Max	Unit
Power Supply	VCCH	4.5	5.0	5.5	V
Power Supply	VCCF	3.0	3.3	3.6	V
Input low voltage	V _{IL}	-0.3		0.8	V
Input high voltage	V _{IH}	2.0		Vcc+0.3	V
Output low voltage	M			0.45 (at	V
Output low voltage	V _{OL}			4mA)	V
Output high voltage	\/	2.4 (at			V
Output high voltage	V _{OH}	1mA)			V
Operating CurrentV	Icc				
Sleep Mode				1.4	mA



Operation			140	mA
Input Leakage Current	ILI		±10	uA
Output leakage current	L _{LO}		±10	μA
Input/output	C		10	nE.
Capacitance	C _{I/O}		10	pF

5.8.3 Timing Specifications

5.8.3.1 Attribute Memory Read Timing Specification

Attribute Memory access time is defined as 300ns. Detailed timing specs are shown in Table 8.

Table 8: Attribute Memory Read Timing

Speed Version			300ns	
Item	Symbol	IEEE Symbol	Min (ns)	Max (ns)
Read cycle time	tc(R)	tAVAV	300	
Address access time	ta(A)	tAVQV		300
Card enable access time	ta(CE)	tELQV		300
Output enable access time	ta(OE)	tGLQV		150
Output disable time from CE	tdis(CE)	tEHQZ		100
Output disable time from OE	tdis(OE)	tGHQZ		100
Address setup time	tsu(A)	tAVGL	30	
Output enable time from CE	ten(CE)	tELQNZ	5	
Output enable time from OE	ten(OE)	tGLQNZ	5	
Data valid from address change	tv(A)	tAXQX	0	

Note: All times are in nanoseconds. Dout signifies data provided by the CompactFlash Storage Card or CF+ Card to the system. The -CE signal or both the -OE signal and the -WE signal shall be de-asserted between consecutive cycle operations.



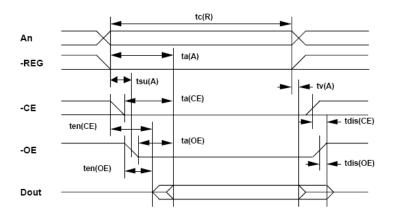


Figure 2: Attribute Memory Read Timing Diagram

5.8.3.2 Configuration Register (Attribute Memory) Write Timing Specification

The Card Configuration write access time is defined as 250ns. Defined timing specifications are shown in Table 9.

Table 9: Configuration Register (Attribute Memory) Write Timing

Speed Version			250ns	
Item	Symbol	IEEE Symbol	Min (ns)	Max (ns)
Write cycle time	tc(W)	tAVAV	250	
Write pulse width	tw(WE)	tWLWH	150	
Address setup time	tsu(A)	tAVWL	30	
Write recovery time	trec(WE)	tWMAX	30	
Data setup time for WE	tsu(D-WEH)	tDVWH	80	
Data hold time	th(D)	tWMDX	30	

Note: All times are in nanoseconds. Din signifies data provided by the system to the CompactFlash storage card or CF+ card.



-Reg
An

-WE

-WE

-CE

-OE

-OE

-OE

Figure 3: Configuration Register (Attribute Memory) Write Timing Diagram

5.8.3.3 Common Memory Read Timing Specification

Table 10: Common Memory Read Timing

Cycle Tin	ne Mode:		250n	ıs	120n	ıs	100n	ıs	80ns	;
Item	Symbol	IEEE	Min	Max	Min	Max	Min	Max	Min	Max
item	Syllibol	Symbol	ns.	ns.	ns.	ns.	ns.	ns.	ns.	ns.
Output										
enable	ta(OE)	tGLQV		125		60		50		40
access	la(OL)	IOLQV		120		00		30		40
time										
Output										
disable	tdis(OE)	tGHQZ		100		60		50		40
time	13115(15-17)									
from OE										
Address										
setup	tsu(A)	tAVGL	30		15		10		10	
time										
Address										
hold	th(A)	tGHAX	20		15		15		10	
time										
CE										
setup	tsu(CE)	tELGL	0		0		0		0	
before										



OE										
CE hold		_								
following	th(CE)	tGHEH	20		15		15		10	
OE										
Wait										
delay	tv(WT-OE)	tGLWTV		35		35		35		Na
falling	[(V(VV 1-OE)	IGLVVIV		35		35		35		iva
from OE										
Data										
setup for	4. /\A/T\	40\/\\/TLI								Na
wait	tv(WT)	tQVWTH		0		0		0		Na
release										
Wait				350		350		350		
	+,,,/\\/\T\	tWTLWTH		(3000		(3000		(3000		No
width	tw(WT)			for		for		for		Na
time	_	_		CF+)		CF+)		CF+)		

Note: 1) –WAIT is not supported in this mode.

2) The maximum load on -WAIT is 1 LSTTL with 50 pF (40pF below 120nsec Cycle Time) total load. All times are in nanoseconds. Dout signifies data provided by the CompactFlash Storage Card or CF+ Card to the system. The -WAIT signal may be ignored if the -OE cycle to cycle time is greater than the Wait Width time. The Max Wait Width time can be determined from the Card Information Structure. The Wait Width time meets the PCMCIA specification of 12µs but is intentionally less in this specification.

Figure 4: Common Memory Read Timing Diagram

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5.8.3.4 Common Memory Write Timing Specification

Table 11: Common Memory Write Timing

Cycle Tim	e Mode:		250n	ıs	120n	ıs	100n	ıs	80ns	;
14 0 100	Cramb al	IEEE	Min	Max	Min	Max	Min	Max	Min	Max
Item	Symbol	Symbol	ns.	ns.	ns.	ns.	ns.	ns.	ns.	ns.
Data Setup before WE	tsu(D-WEH)	tDVWH	80		50		40		30	
Data Hold following WE	th(D)	tWMDX	30		15		10		10	
WE Pulse Width	tw(WE)	tWLWH	150		70		60		55	
Address Setup Time	tsu(A)	tAVWL	30		15		10		10	
CE Setup before WE	tsu(CE)	tELWL	0		0		0		0	
Write Recovery Time	trec(WE)	tWMAX	30		15		15		15	
Address Hold Time	th(A)	tGHAX	20		15		15		15	
CE Hold following WE	th(CE)	tGHEH	20		15		15		10	
Wait Delay Falling from WE	tv(WT-WE)	tWLWTV		35		35		35		Na

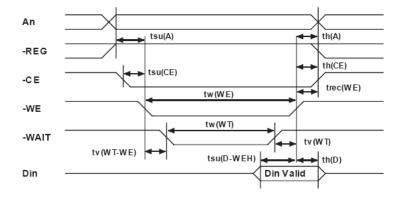


WE High from Wait Release	tv(WT)	tWTHWH	0		0		0		na	
Wait Width Time	tw(WT)	tWTLWTH		350 (3000 for <i>CF</i> +)		350 (3000 for <i>CF</i> +)		350 (3000 for <i>CF</i> +)		Na

Notes: 1) –WAIT is not supported in this mode.

2) The maximum load on -WAIT is 1 LSTTL with 50 pF (40pF below 120nsec Cycle Time) total load. All times are in nanoseconds. Din signifies data provided by the system to the CompactFlash Storage Card. The -WAIT signal may be ignored if the -WE cycle to cycle time is greater than the Wait Width time. The Max Wait Width time can be determined from the Card Information Structure. The Wait Width time meets the PCMCIA specification of 12µs but is intentionally less in this specification.

Figure 5: Common Memory Write Timing Diagram



5.8.3.5 I/O Input (Read) Timing Specification

Table 12: I/O Read Timing

Cycle Time	Mode:		250ns		120ns		100ns		80ns	s
Item	Symbol	IEEE Symbol	Min ns.	Max ns.	Min ns.	Max ns.	Min ns.	Max ns.	Min ns.	Max ns.
Data Delay after	td(IORD)	tlGLQV		100		50		50		45

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IORD										
Data Hold										
following	th(IORD)	tIGHQX	0		5		5		5	
IORD										
IORD										
Width	tw(IORD)	tlGLIGH	165		70		65		55	
Time										
Address										
Setup	tsuA(IORD)	tAVIGL	70		25		25		15	
before	(
IORD										
Address										
Hold	thA(IORD)	tIGHAX	20		10		10		10	
following	,									
IORD										
CE Setup before	touCE(IODD)	4E1 101	5		_		5		5	
IORD	tsuCE(IORD)	tELIGL	5		5		5		5	
CE Hold										
following	thCE(IORD)	tlGHEH	20		10		10		10	
IORD		tiOi iLi i	20							
REG										
Setup										
before	tsuREG(IORD)	tRGLIGL	5		5		5		5	
IORD										
REG Hold										
following	thREG(IORD)	tIGHRGH	0		0		0		0	
IORD										
INPACK										
Delay	tdfINPACK(IORD)	tlGLIAL	0	45	0	Na1	0	Na1	0	Na1
Falling	(dilly)	"OLIAL		10		1401		1401		INGI
from IORD										
INPACK										
Delay	tdrINPACK(IORD)	tlGHIAH		45		Na1		Na1		Na1
Rising										
from IORD										
IOIS16	tdfIOIS16(ADR)	tAVISL		35		Na1		Na1		Na1
Delay	, ,									



Falling						
from						
Address						
IOIS16						
Delay						
Rising	tdrlOIS16(ADR)	tAVISH	35	Na1	Na1	Na1
from						
Address						
Wait Delay						
Falling	tdWT(IORD)	tIGLWTL	35	35	35	Na2
from IORD						
Data						
Delay from	td(WT)	tWTHQV	0	0	0	Na2
Wait	tu(vvi)	tvviiiQv	0	O	0	INAL
Rising						
			350	350	350	
Wait Width	tw(WT)	tWTLWTH	(3000	(3000	(3000	Na2
Time	(vv(vv 1 <i>)</i>	[[[[[[[[[[[[[[[[[[[for	for	for	INAL
			CF+)	CF+)	CF+)	

Notes:1) -IOIS16 and -INPACK are not supported in this mode.

- 2) -WAIT is not supported in this mode.
- 3) Maximum load on -WAIT, -INPACK and -IOIS16 is 1 LSTTL with 50 pF (40pF below 120nsec Cycle Time) total load. All times are in nanoseconds. Minimum time from -WAIT high to -IORD high is 0 nsec, but minimum -IORD width shall still be met. Dout signifies data provided by the CompactFlash Storage Card or CF+ Card to the system. Wait Width time meets PCMCIA specification of 12µs but is intentionally less in this spec.

-CE tsu(CE) th(CE)

-OE tw(WT)

tv(WT-OE) tv(WT)

tv(WT)

Figure 6: I/O Read Timing Diagram

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5.8.3.6 I/O Input (Write) Timing Specification

Table 13: I/O Write Timing

Cycle Time Mode	e:		250ı	าร	120	ns	100	ns	80n	S
Itam	Sumb al	IEEE	Min	Max	Min	Max	Min	Max	Min	Max
Item	Symbol	Symbol	ns.	ns.	ns.	ns.	ns.	ns.	ns.	ns.
Data Setup before IOWR	tsu(IOWR)	tDVIWH	60		20		20		15	
Data Hold following IOWR	th(IOWR)	tlWHDX	30		10		5		5	
IOWR Width Time	tw(IOWR)	tlWLIW H	165		70		65		55	
Address Setup before IOWR	tsuA(IOWR)	tAVIWL	70		25		25		25	
Address Hold following IOWR	thA(IOWR)	tIWHAX	20		20		10		10	
CE Setup before IOWR	tsuCE(IOWR)	tELIWL	5		5		5		5	
CE Hold following IOWR	thCE(IOWR)	tIWHEH	20		20		10		10	
REG Setup before IOWR	tsuREG(IOW R)	tRGLIW L	5		5		5		5	
REG Hold following IOWR	thREG(IOW R)	tlWHRG H	0		0		0		0	
IOIS16 Delay Falling from Address	tdfIOIS16(A DR)	tAVISL		35		Na1		Na1		Na1
IOIS16 Delay Rising from Address	tdrlOIS16(A DR)	tAVISH		35		Na1		Na1		Na1
Wait Delay Falling from IOWR	tdWT(IOWR)	tlWLWT L		35		35		Na2		Na2
IOWR high from Wait high	tdrIOWR(WT	tWTJIW H	0		0			0		Na2
Wait Width Time	tw(WT)	tWTLW TH		350 (3000 for		350 (3000 for		350 (3000 for		Na2



		o- \			i
		/ 'L ı \	CET)	CET)	i
		OF+)	C(T)	OI T)	i
		,	,	,	i

Notes: 1) -IOIS16 and -INPACK are not supported in this mode.

- 2) -WAIT is not supported in this mode.
- 3) The maximum load on -WAIT, -INPACK, and -IOIS16 is 1 LSTTL with 50 pF (40pF below 120nsec Cycle Time) total load. All times are in nanoseconds. Minimum time from -WAIT high to -IOWR high is 0 nsec, but minimum -IOWR width shall still be met. Din signifies data provided by the system to the CompactFlash Storage Card or CF+ Card. The Wait Width time meets the PCMCIA specification of 12 μ s but is intentionally less in this specification.

Αn tsuA(IOWR) tsuREG(IOWR) thA(IOWR) -REG thREG(IOWR) tsuCE(IOWR) -CE thCE(IOWR) tw(IOWR) -IOWR tdrlOIS16(ADR) tsu(IOWR) -IOIS16 tdflOIS16(ADR) tw (WT) -WAIT th(IOWR) tdWT(IOWR) tdrlOWR(WT) Din Din Valid

Figure 7: I/O Write Timing Diagram

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5.8.3.7 True IDE PIO Mode Read/Write Timing Specification

ADDR valid (HAB[2:0], CS0-, CS1-)

HIOR-/HIOW
Write Data (HDB[15:0])

Read Data (HDB[15:0])

IOCS16
IORDY

IORDY

Tornor table t

Figure 8: Read/Write Timing Diagram, PIO Mode

Table 14: Read/Write Timing Specifications, PIO Mode 0-6

DIC	A dimeira e managementana	Mod						
אַר	timing parameters	e 0	e 1	e 2	e 3	e 4	e 5	e 6
t_0	Cycle time (min.)	600	383	240	180	120	100	80
t ₁	Address valid to HIOR-/HIOW- setup (min.)	70	50	30	30	25	15	10
t_2	HIOR-/HIOW- 16-bit (min.)	165	125	100	80	70	65	55
t ₂	HIOR-/HIOW- Register 8-bit (min.)	290	290	290	80	70	65	55
t _{2i}	HIOR-/HIOW- recovery time (min.)	-	-	-	70	25	25	20
t_3	HIOW- data setup (min.)	60	45	30	30	20	20	15
t_4	HIOW- data hold (min.)	30	20	15	10	10	5	5
t ₅	HIOR- data setup (min.)	50	35	20	20	20	15	10
t ₆	HIOR- data hold (min.)	5	5	5	5	5	5	5



t _{6z}	HIOR- data tri-state (max.)	30	30	30	30	30	20	20
t ₇	Address valid to IOCS16-	90	50	40	n/a	n/a	n/a	n/a
	assertion (max.)							
١.	Address valid to IOCS16-	00	45	20	- /-	- /-	n/a	n/a
t ₈	released (max.)	60	45	30	n/a	n/a		
t ₉	HIOR-/HIOW- to address	20	15	10	10	10	10	10
ι 9	valid hold	20	13	10	10	10		
t_{R}	Read data valid to IORDY	0	0	0	0	0	0	0
D	active (min.)	U	U	U	U	U		
t_{A}	IORDY setup time	35	35	35	35	35	n/a	n/a
t_{B}	IORDY pulse width (max.)	1250	1250	1250	1250	1250	n/a	n/a
to	IORDY assertion to release	5	5	5	5	5	n/a	n/a
t _C	(max.)	5	5	3	3	3		

5.8.3.8 True IDE Multiword DMA Mode Read/Write Timing Specification

Figure 9: Read/Write Timing Diagram, Multiword DMA Mode

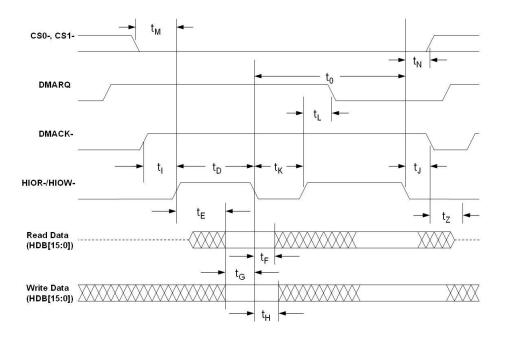




Table 15: Read/Write Timing Specifications, Multiword DMA Mode 0-4

Mu	Itiword DMA timing	Mode 0	Mode 1	Mode 2	Mode 3	Mode 4
par	rameters					
t_0	Cycle time (min.)	480	150	120	100	80
t _D	HIOR-/HIOW- assertion width (min.)	215	80	70	65	55
t _E	HIOR- data access (max.)	150	60	50	50	45
t_{F}	HIOR- data hold (min.)	5	5	5	5	5
t _G	HIOR-/HIOW- data setup (min.)	100	30	20	15	10
t _H	HIOW- data hold (min.)	20	15	10	5	5
tı	DMACK to HIOR-/HIOW-setup (min.)	0	0	0	0	0
tJ	HIOR-/HIOW- to DMACK hold (min.)	20	5	5	5	5
t _K R	HIOR- negated width (min.)	50	50	25	25	20
t _K w	HIOW- negated width (min.)	215	50	25	25	20
t _L R	HIOR- to DMARQ delay (max.)	120	40	35	35	35
t _L	HIOW- to DMARQ delay (max.)	40	40	35	35	35
t _M	CS1-, CS0- valid to HIOR-/HIOW-	50	30	25	10	5
t_N	CS1-, CS0- hold	15	10	10	10	10
t_Z	DMACK-	20	25	25	25	25

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5.8.3.9 True IDE Ultra DMA Mode Read/Write Timing Specification

Figure 10: Ultra DMA Mode Data-in Burst Initiation Timing Diagram

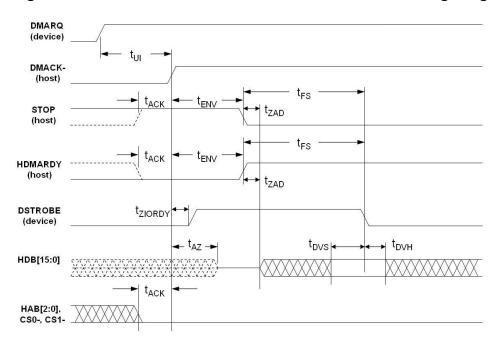
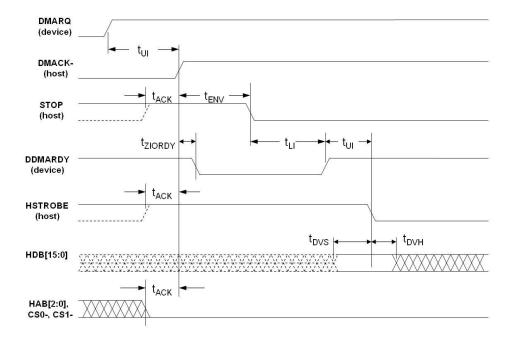


Figure 11: Ultra DMA Mode Data-out Burst Initiation Timing Diagram





HDB[15:0] (host)

DSTROBE (device) $\mathbf{t}_{\text{DVHIC}}$ $\mathbf{t}_{\mathrm{DVS}}$ \mathbf{t}_{DVS} \mathbf{t}_{DVH} t_{DVSIC} $t_{\rm DVSIC}$ $\mathbf{t}_{\mathrm{DVHIC}}$ t_{DVHIC} HDB[15:0] (device) **DSTROBE** (host) \mathbf{t}_{DH} \mathbf{t}_{DS} \mathbf{t}_{DH} \mathbf{t}_{DS} $\mathbf{t}_{\mathrm{DHIC}}$ $\mathbf{t}_{\mathrm{DSIC}}$

 $\mathbf{t}_{\mathrm{DHIC}}$

 $\mathbf{t}_{\mathrm{DHIC}}$

 $t_{\rm DSIC}$

Figure 12: Sustained Ultra DMA Mode Data-in Burst Timing Diagram

Figure 13: Sustained Ultra DMA Mode Data-out Burst Timing Diagram

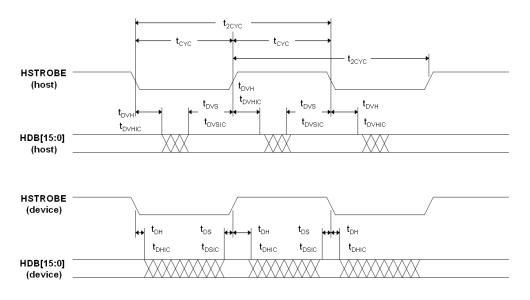


Table 16: Timing Diagram, Ultra DMA Mode 0-4

I III4ma	DMA timing parameters	Mod	le 0	Mode 1		Mode 2		Mod	Mode 3		le 4
Uitra	DMA timing parameters	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
tanya	Typical sustained average two	240	_	160	_	120		90	-	60	-
t _{2CYC}	cycle time	240	.40	100	_	120					
	Cycle time allowing for										
t_{CYC}	asymmetry and clock variations	112	-	73	-	54	-	39	-	25	-
	(from STROBE edge to										



	STROBE edge)										
t _{2CYC}	Two cycle time allowing for clock variations (from rising edge to next rising edge or from falling edge to next falling edge of STROBE)	230	-	153	-	115	-	86	-	57	1
t _{DS}	Data setup time (at recipient)	15	-	10	-	7	-	7	-	5	-
t _{DH}	Data hold time (at recipient)	5	-	5	-	5	-	5	-	5	-
t _{DVS}	Data valid setup time at sender (from data bus being valid until STROBE edge)	70	ı	48	-	31	-	20	-	6.7	-
t _{DVH}	Data valid hold time at sender (from STROBE edge until data may become invalid)	6.2	-	6.2	-	6.2	-	6.2	-	6.2	-
t _{FS}	First STROBE time (for device to first negate DSTROBE from STOP during a data in burst)	-	230	-	200	-	170	-	130	-	120
Ultra DMA timing parameters			le 0	Mod	le 1	Mod	le 2	Mod	le 3	Mod	le 4
Oitia	DWA tilling parameters	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
t _{LI}	Limited interlock time	0	150	0	150	0	150	0	100	0	100
t _{MLI}	Interlock time with minimum	20	-	20	-	20	-	20	-	20	-
t _{UI}	Unlimited interlock time	0	-	0	-	0	-	0	-	0	-
t _{AZ}	Maximum time allowed for output drivers to release (from being asserted or negated)	-	10	-	10	-	10	-	10	-	10
t_{ZAH}	Minimum delay time required for	20	ı	20	-	20	-	20	-	20	-
t _{ZAD}	output drivers to assert or negate (from released state)	0	-	0	-	0	-	0	-	0	-
	Envelope time (from DMACK- to										
t _{ENV}	STOP and HDMARDY- during data out burst initiation)	20	70	20	70	20	70	20	55	20	55
t _{ENV}	STOP and HDMARDY- during	-	70 75	-	70	-	70 60	-	55 60	-	55 60

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	DMARDY-)										
t _{IORD}	Pull-up time before allowing	1	20	-	20	-	20	-	20	-	20
YZ	IORDY to be released										
t_{ZIOR}	Minimum time device shall wait	0	_	0	_	0	_	0	_	0	
DY	before driving IORDY)		O		U		Ü		U	
	Setup and hold times for										
t _{ACK}	DMACK- (before assertion or	20	-	20	-	20	-	20	-	20	-
	negation)										
	Time from STROBE edge to										
+	negation of DMARQ or	50		50	_	50	_	20		20	
t _{SS}	assertion of STOP (when	50		50	-	50	-	20	-	20	_
	sender terminates a burst)										

5.9 **Transfer Function**

(8 bits)

42

L

L

Н

L

5.9.1 I/O Transfer function

The I/O transfer to or from the iCF4000 can be either 8 or 16 bits. When a 16 bit accessible port is addressed, the signal -IOIS16 is asserted by the iCF4000. Otherwise, the –IOIS16 signal is de-asserted. When a 16 bit transfer is attempted and the -IOIS16 signal is not asserted by the iCF4000, the system shall generate a pair of 8 bit references to access the word's even byte and odd byte. The iCF4000 permits both 8 and 16 bit accesses to all of its I/O addresses, so -IOIS 16 is asserted for add address to which the iCF4000 responds.

The iCF4000 may request the host to extend the length of an input cycle until data ready by asserting the –WAIT signal at the start of the cycle.

Function Code -REG -CE1 -IORD -IOWR D15~D8 D7~D0 -CE2 Α0 Standby Mode Χ Η Η Χ Χ Χ High Z High Z Н L Н Byte Input Access L High Z Even-Byte L L (8 bits) Н Н High Z Η Odd-Byte Byte Output Access L Н L L Н L Don't Care Even-Byte

Table 17: PCMCIA Mode I/O Function

L

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Н

Н

L

L

Н

Don't Care

Odd-Byte

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Odd-Byte

Even-Byte



Access (16bits)								
I/O Read Inhibit	Н	Χ	X	Х	L	Н	Don't Care	Don't Care
I/O Write Inhibit	Н	X	Χ	Х	Н	L	High Z	High Z
High Byte Input	L	L	Н	Х	L	Н	Odd-Byte	High Z
Only (8 bits)								
High Byte Output	L	L	Н	Х	Н	L	Odd-Byte	Don't Care
Only (8bits)								

5.9.2 Common Memory Transfer Function

The Common Memory transfer to or from iCF4000 can be either 8 or 16 bits.

The iCF4000 permits both 8 and 16 bit access to all of its Common Memory addresses.

The iCF4000 request the host to extend the length of a memory write cycle or extend the length of a memory read cycle until data is ready by asserting the –WAIT signal at the start of the cycle.

Table 18: Common Memory Function

Function Code	-REG	-CE2	-CE1	Α0	-OE	-WE	D15~D8	D7~D0
Standby Mode	Х	Н	Н	Х	Х	Х	High Z	High Z
Byte Read Access	Н	Н	L	L	L	Н	High Z	Even-Byte
(8 bits)	Н	Н	L	Н	L	Н	High Z	Odd-Byte
Byte Write Access	Н	Н	L	L	Н	L	Don't	Even-Byte
(8 bits)	Н	Н	L	Н	Н	L	Care	Odd-Byte
							Don't	
							Care	
Word Input Access (16bits)	Н	L	L	X	L	Н	Odd-Byte	Even-Byte
Word Output Access (16bits)	Н	L	L	х	Н	L	Odd-Byte	Even-Byte
Odd Byte Read Only (8 bits)	Н	L	Н	Х	L	Н	Odd-Byte	High Z
Odd Byte Write Only (8bits)	Н	L	Н	X	Н	L	Odd-Byte	Don't Care



5.9.3 True IDE Mode I/O Transfer Function

The iCF4000 can be configured in a True IDE Mode of operation. The iCF4000 is configured in this mode only when –OE input signal is grounded by the host during the power off to power on cycle.

Table 19: True IDE Mode I/O Function

Function Code	-CS1	-CS0	-A0~A2	-DMACK	-IORD	-IOWR	D15~D8	D7~D0
	L	L	Х	Х	Х	Х	Undefined	Undefined
							In/Out	In/Out
	L	Х	Х	L	L	Х	Undefined	Undefined
							Out	Out
Invalid Mode	L	Х	Х	L	Х	L	Undefined	Undefined
							In	In
	X	L	X	L	L	X	Undefined	Undefined
							Out	Out
	X	L	Х	L	X	L	Undefined	Undefined
							In	In
Standby Mode	Н	Н	X	Н	X	X	High Z	High Z
Task File Write	Н	L	1-7h	Н	Н	L	Don't Care	Data In
Task File Read	Н	L	1-7h	Н	L	Н	High Z	Data In
PIO Data	Н	L	0	Н	Н	L	Odd-Byte	Even-Byte
Register Write							In	In
DMA Data	Н	н	X	L	Н	L	Odd-Byte	Even-Byte
Register Write							In	In
Ultra DMA	н	н	X	L	See Not	e 1	Odd-Byte	Even-Byte
Data Register							In	In
Write								
PIO Data	Н	L	0	Н	L	Н	Odd-Byte	Even-Byte
Register Read							Out	Out
DMA Data	Н	н	X	L	L	Н	Odd-Byte	Even-Byte
Register Read							Out	Out
Ultra DMA	Н	н	X	L	See Not	e 2	Odd-Byte	Even-Byte
Data Register							Out	Out
Read						,		
Control	L	н	6h	Н	Н	L	Don't Care	Control In
Register Write								



Alt Status	L	Н	6h	Н	L	Н	High Z	Status Out
Read								
Drive Address	L	Н	7h	Н	L	Н	High Z	Data Out

Note1: In Ultra DMA Data Register Write mode the signals –IORD, -IOWR and IORDY are redefined and used as follows: -IORD as HSTROBE, -IOWR as STOP and IORDY as –DDMARDY. Data transfers with each edge of HSTROBE.

Note2: In Ultra DMA Data Register Read mode the signals –IORD, -IOWR and IORDY are redefined and used as follows: -IORD as –HDMARDY H, -IOWR as STOP and IORDY as DSTROBE. Data transfer with each edge of DSTROBE.

5.10 Configuration Register

5.10.1 Configuration Option Register (200h in Attribute Memory)

The Configuration Option Register is used to configure the cards interface, address decoding and interrupt and to issue a soft reset to the iCF4000.

Figure 14: Configuration Option Register

Operation	D7	D6	D5	D4	D3	D2	D1	D0
R/W	SRESET	LevelREQ	Conf5	Conf4	Conf3	Conf2	Conf1	Conf0

Table 20: Information for Configuration Option Register

Name	Description
SRSET	Soft Reset: Setting this bit to one (1), waiting the minimum reset time
	and returning to zero(0) places the iCF4000 in the reset state. Setting
	this bit to one (1) is equivalent to assertion of the +RESET signal except
	that the SRESET bit is not cleared. Returning this bit to zero (0) leaves
	the iCF4000 in the same un-configured, Reset state as following
	power-up and hardware reset. This bit is PCMCIA Soft Reset is
	considered a hard Reset by the ATA Commands. Contrast with Soft
	Reset in the Device Control Register.
LevelREQ	This bit is set to one (1) then Level Mode Interrupt is selected, and zero
	(0) then Pulse Mode is selected. Set to zero (0) by Reset.
Conf5-0	Configuration Index: Set to zero (0) by reset. It is used to select
	operation mode of the iCF4000 as shown below



Note: Conf5 and Conf4 are reserved for CompactFlash Storage cards and shall be written as zero(0).

Table 21:iCF4000 Configuration

Conf5	Conf4	Conf3	Conf2	Conf1	Conf0	Disk Card Mode
0	0	0	0	0	0	Memory Mapped
0	0	0	0	0	1	I/O Mapped, Any 16 byte
						system decoded boundary
0	0	0	0	1	0	Primary I/O Mapped,
						1F0h~1F7h/3F6h ~ 3F7h
0	0	0	0	1	1	Secondary I/O Mapped,
						170h~177h/376h ~ 377h

5.10.2 Card Configuration and Status Register (202h in Attribute Memory)

The Card configuration and Status Register contains information about the Card's condition.

Figure 15: Card Configuration and Status Register

Operation	D7	D6	D5	D4	D3	D2	D1	D0
Read	Changed	SigChg	IOis8	0	0	PwrDwn	Int	0
Write	0	SigChg	IOis8	0	0	PweDwn	0	0

Table 22: Information for Card Configuration and Status Register

Name	Description
Changed	Indicates that one or both of the Pin Replacement register
	CReady. Or CWProt bits are set to one(1). When the changed
	bit is setSTSCHG Pin 46 us held low if the SigChg bit is a
	One(1) and the iCF4000 is configured for I/O interface.
SigChg	This bit is set and reset by the host to enable and disable a
	state-change "single" from the Status Register, the Changed bit
	controls pin 46, the Changed Status single. If no state change
	single is descried, this bit is set to zero(0) and pin46 (-STSCHG)
	single is then held high while the iCF4000 is configured for I/O.
IOis8	The host sets this bit to one (1) if the iCF4000 is to be
	configured in an 8 bit I/O Mode. The iCF4000 is always
	configured for both 8 and 16 bit I/O, so this bit is ignored.

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PwrDwn	This bit indicates whether the host requests iCF4000 to be in the
	power saving or active mode. When the bit is one (1), the
	iCF4000 enter a power down mode. The PwrDwn is zero (0),
	the host is requesting the iCF4000 to enter the active mode. The
	PCMCIA READY value becomes false (busy) when this bit is
	changed. READY shall not become true (ready) until the power
	state requested has been entered. The iCF4000 automatically
	powers down when it is idle and powers back up when it
	receives a command.
Int	This bit represents the internal state of the interrupt request.
	This value is available whether or not the I/O interface has been
	configured. This signal remains true until the condition that
	caused the interrupt request has been serviced. If interrupts are
	disabled by the –IEN bit in the Device Control Register, this bit is
	a zero (0).

5.10.3 Pin Replacement register (204h in Attribute Memory)

Figure 16: Pin Replacement Register

Operation	D7	D6	D5	D4	D3	D2	D1	D0
Read	0	0	CReady	0	1	1	RReady	0
Write	0	0	CReady	0	0	0	MReady	0

Table 23: Information for Pin Replacement Register

Name	Description							
CReady	This bit is set to one (1) when the bit RReady changes state. This							
	bit can also be written by the host.							
RReady	This bit is used to determine the internal state of the READY							
	signal. This bit may be used to determine the state of the READY							
	signal as this pin has been reallocated for use as Interrupt							
	Request on an I/O card. When written, this bit acts as a							
	mask(MReady) for writing the corresponding bit CReady.							
MReady	This bit acts as a mask for writing corresponding bit CReady.							

5.10.4 Socket and Copy Register (206h in Attribute Memory)

This register contains additional configuration information. This register is always

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written by the system before writing the card's Configuration Index Register. This register is used for identification of the card from the other card.

Figure 17: Socket and Copy Register

Operation	D7	D6	D5	D4	D3	D2	D1	D0
Read	0	0	0	Obsolete	0	0	0	0
				(Drive #)				
Write	0	0	0	Obsolete	Х	Х	Х	Х
				(Drive #)				

Table 24: Information for Socket and Copy Register

Name	Description
Obsolete(Drive #)	This bit is obsolete and should be written as 0.

5.11 Software Interface

5.11.1 CF-ATA Drive Register Set Definition and Protocol

The iCF4000 can be configured as a high performance I/O device through:

- a) The standard PC-AT disk I/O address 1F0h-1F7h, 3F6h-3F7h (primary) or 170h-177h, 376h-377h (secondary) with IRQ14 (or other available IRQ).
- b) Any system decode 16 byte I/O block using any available IRQ.
- c) Memory space

The communication to or from the card is done using the Task File register, which provide all the necessary register for control and status information related to the storage medium. The PCMCIA interface connects peripherals to the host using four register mapping methods.

Table 25: I/O Configuration

Standard Configurations										
Config Index	I/O or Memory Address Description									
0	Memory	0h-Fh, 400h-7FFh	Memory Mapped							
1	I/O	XX0h-XXFh	I/O Mapped 16							
			Contiguous							
			Registers							



2	I/O	1F0h-1F7h,	Primary	I/O
		3F6h-3F7h	Mapped	
3	I/O	170h-177h,	Secondary	I/O
		376h-377h	Mapped	

5.11.2 I/O Primary and Secondary Address Configurations

Table 26: Primary and Secondary I/O Decoding

-REG	A9-A4	А3	A2	A1	A0	-IORD=0	-IOWR=0	Note
0	1F(17)h	0	0	0	0	Even RD Data	Even WR Data	1,2
0	1F(17)h	0	0	0	1	Error Register	Features	1,2
0	1F(17)h	0	0	1	0	Sector Count	Sector Count	
0	1F(17)h	0	0	1	1	Sector No.	Sector No.	
0	1F(17)h	0	1	0	0	Cylinder Low	Cylinder Low	
0	1F(17)h	0	1	0	1	Cylinder High	Cylinder High	
0	1F(17)h	0	1	1	0	Select Card/Head	Select	
							Card/Head	
0	1F(17)h	0	1	1	1	Status	Command	
0	3F(37)h	0	1	1	0	Alt Status	Device Control	
0	3F(37)h	0	1	1	1	Drive Address	Reserved	

Note 1) Register 0 is accessed with –CE1 low and –CE2 low (and A0=Don't care) as a word register on the combined Odd Data Bus and Even Data Bus (D15-D0). This register may also be accessed by a pair of byte access to the offset 0 with –CE1 low and –CE2 high. Note that the address space of this word register overlaps the address space of the Error and Feature byte-wide registers, which lie at offset 1. When accessed twice as byte register with –CE1 low, the first byte to be accessed is the even byte of the word and the second byte accessed is the odd byte of the equivalent word access.

Note2) A byte access to register 0 with -CE1 high and -CE2 low access the error (read) or feature (write) register.

5.11.3 Contiguous I/O Mapped Addressing

When the system decodes a contiguous block of I/O registers to select the card, the registers are accessed in the block of I/O space decoded by the system as follows:

Table 27: Contiguous I/O Decoding

-REG	A3 A2	A1	A0	Offset	-IORD=0	-IOWR=0	Note
------	-------	----	----	--------	---------	---------	------



0	0	0	0	0	0	Even RD Data	Even WR Data	1
0	0	0	0	1	1	Error	Features	2
0	0	0	1	0	2	Sector Count	Sector Count	
0	0	0	1	1	3	Sector No.	Sector No.	
0	0	1	0	0	4	Cylinder Low	Cylinder Low	
0	0	1	0	1	5	Cylinder High	Cylinder High	
0	0	1	1	0	6	Select Card/Head	Select Card/Head	
0	0	1	1	1	7	Status	Command	
0	1	0	0	0	8	Dup Even RD Data	Dup. Even WR	2
							Data	
0	1	0	0	1	9	Dup. Odd RD Data	Dup. Odd WR	2
							Data	
0	1	1	0	1	D	Dup. Error	Dup. Feature	2
0	1	1	1	0	Е	Alt Status	Device Ctl	
0	1	1	1	1	F	Drive Address	Reserved	

Note 1) Register 0 is accessed with –CE1 low and –CE2 low (and A0=Don't care) as a word register on the combined Odd Data Bus and Even Data Bus (D15-D0). This register may also be accessed by a pair of byte access to the offset 0 with –CE1 low and –CE2 high. Note that the address space of this word register overlaps the address space of the Error and Feature byte-wide registers that lie at offset 1. When accessed twice as byte register with –CE1 low, the first byte to be accessed is the even byte of the word and the second byte accessed is the odd byte of the equivalent word access.

Note 2) A byte access to register 0 with -CE1 high and -CE2 low access the error (read) or feature (write) register.

Note 3) Address lines that are not indicated are ignored by the card for accessing all the registers in this table.

5.11.4 Memory Mapped Addressing

When the card registers are accessed via memory references, the register appears in the common memory space window: 0-2K bytes as follows:

Table 28: Memory Mapped Decoding

-REG	A10	A9-A4	А3	A2	A1	A0	Offset	-OE=0		-WE=0		Note
1	0	Χ	0	0	0	0	0	Even	RD	Even	WR	1,2
								Data		Data		
1	0	Χ	0	0	0	1	1	Error		Feature	S	1,2
1	0	Χ	0	0	1	0	2	Sector C	Count	Sector		
										Count		



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									•	
1	0	X	0	0	1	1	3	Sector No.	Sector No.	
1	0	X	0	1	0	0	4	Cylinder Low	Cylinder Low	
1	0	Х	0	1	0	1	5	Cylinder	Cylinder	
								High	High	
1	0	Х	0	1	1	0	6	Select	Select	
								Card/Head	Card/Head	
1	0	Х	0	1	1	1	7	Status	Command	
1	0	Х	1	0	0	0	8	Dup Even	Dup. Even	2
								RD Data	WR Data	
1	0	Х	1	0	0	1	9	Dup. Odd	Dup. Odd	2
								RD Data	WR Data	
1	0	Х	1	1	0	1	D	Dup. Error	Dup.	2
									Feature	
1	0	Х	1	1	1	0	Е	Alt Status	Device Ctl	
1	0	Х	1	1	1	1	F	Drive	Reserved	
								Address		
1	1	Х	Х	Χ	Χ	0	8	Even RD	Even WR	3
								Data	Data	
1	1	Х	Χ	Χ	Х	1	9	Odd Rd Data	Odd WR	3
									Data	

Note 1) Register 0 is accessed with –CE1 low and –CE2 low as a word register on the combined Odd Data Bus and Even Data Bus (D15-D0). This register may also be accessed by a pair of byte access to the offset 0 with –CE1 low and –CE2 high. Note that the address space of this word register overlaps the address space of the Error and Feature byte-wide registers that lie at offset 1. When accessed twice as byte register with –CE1 low, the first byte to be accessed is the even byte of the word and the second byte accessed is the odd byte of the equivalent word access. A byte accesses to register 0 with –CE1 high and –CE2 low access the error (read) or feature (write) register.

Note 2) Register at offset 8, 9 and D are non-overlapping duplicates of the registers at offset 0 and 1. Register 8 is equivalent to register 0, while register 9 accesses the odd byte. Therefore, if the register is byte accessed in the order 9 then 8 the data shall be transferred odd byte then even byte. Repeated byte accessed to register 8 or 0 shall access consecutive (even then odd) bytes from the data buffer. Repeated word accesses to register 8, 9 or 0 shall access consecutive words from the data buffer. Repeated byte accesses to register 9 are not supported. However, repeated alternating byte accesses to register 8 then 9 shall access consecutive (even then odd) bytes from the data buffer. Byte accesses to register 9 access only the odd byte of the data.

Note 3) Accesses to even addresses between 400h and 7FFh access register 8. Accesses to odd



addresses between 400h and 7FFh access register 9. This 1 K byte memory window to the data register is provide so that hosts can perform memory block moves to the data register when the register lies in memory space.

Some hosts, such as the X86 processors, must increment both the source and destination addresses when executing the memory to memory block move instruction, Some PCMCIA socket adapters also have auto incrementing address logic embedded within them. This address window allows these hosts and adapters to function efficiently. Note that this entire window accesses the Data Register FIFO and does not allow random access to the data buffer within the card. A word access to address at offset 8 shall provide even data on the low-order byte of the data bus, along with odd data at offset 9 on the high-order byte of the bus.

5.11.5 True IDE Mode Addressing

When the iCF4000 is configured in the True IDE mode, the I/O decoding is as follows:

-CS1 -DMACK -CS0 Α0 -IORD=0 A2 Α1 -IOWR=0 Note 1 0 0 0 0 1 PIO RD Data PIO WR Data 8 or 16 bit 1 1 X X 0 DMA RD Data DMA WR Data 16 bit Χ 1 0 0 1 1 Error Register 0 **Features** 8 bit 1 0 1 1 Sector Count **Sector Count** 8 bit 0 0 1 0 0 1 1 1 Sector No. Sector No. 8 bit 1 0 1 0 0 1 Cylinder Low Cylinder Low 8 bit 1 0 1 0 1 1 Cylinder High Cylinder High 8 bit 1 0 1 1 0 1 Select Select 8 bit Card/Head Card/Head 1 1 1 1 1 1 Status Command 8 bit 0 1 1 1 1 Alt Status **Device Control** 8 bit 0

Table 29: True IDE Mode I/O Decoding

5.11.6 CF-ATA Register

The following section describes the hardware registers used by the host software to issue commands to the iCF4000.

Note:

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In accordance with the PCMCIA specification: each of the registers below that is located at an odd offset address may be accessed in the PC Card Memory or PC



Card I/O modes at its normal address and also the corresponding even address (normal address -1) using data bus lines (D15-D8) when -CE1 is high and -CE2 is low unless -IOIS16 is high (not asserted by the card) and an I/O cycle us being performed.

In True IDE Mode of operation, the size of the transfer is based solely on the register being addressed. All registers are 8 bit only except for the Data Register, which is normally 16 bits, but can be programmed to use 8 bit transfers for Non-DMA operations through the use of the Set Features command. The data register is also 8 bits during a portion of the Read Long and Write Long commands, which exist solely for historical reasons and should not be used.

5.11.6.1 Data Register

The Data Register is a 16 bit register, and it is used to transfer data blocks between the card and the host. This register overlaps the Error Register. This register can be accessed in word and byte mode.

Table 30: Data Register

Data F	Register	•													
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

5.11.6.2 Error Register

This register contains additional information about the source of an error when an error is indicated in bit 0 of the Status register. The bits are defined as follows:

Table 31: Error Register

BBK	UNC	0	IDNF	0	ABRT	0	AMNF
D7	D6	D5	D4	D3	D2	D1	D0

5.11.6.3 Feature Register

This register provides information regarding features of the card that the host can utilize. This register is also accessed in PC Card modes on data D15-D8 during a write operation to Offset 0 with –CE2 low and –CE1 high.



Table 32: Feature Register

Feature Register									
D7	D6	D5	D4	D3	D2	D1	D0		

5.11.6.4 Sector Count Register

This registers the number of sectors of data requested to be transferred on a read or write operation between the host and the card. If the value in this register is zero, a count of 256 sectors is specified. If the command was successful, this register is zero at command completion. If not successfully completed, the register contains the number of sectors that need to be transferred in order to complete the request.

Table 33: Sector Count Register

Sector Count Register									
D7	D6	D5	D4	D3	D2	D1	D0		

5.11.6.5 Sector Number Register

This register contains the starting sector number or bits 7-0 of the Logical Block Address (LBA) for iCF4000 data access for the subsequent command.

Table 34: Sector Number Register

Sector Number Register										
D7	D6	D5	D4	D3	D2	D1	D0			

5.11.6.6 Cylinder Low Register

This Register contains the low order 8 bits of the starting cylinder address or bits 15-8 of the Logical Block Address.

Table 35: Cylinder Low Register

Cylinder Lo	Cylinder Low Register									
D7	D6	D5	D4	D3	D2	D1	D0			

5.11.6.7 Cylinder High Register

This Register contains the high order 8 bits of the starting cylinder address or bits



23-16 of the Logical Block Address.

Table 36: Cylinder High Register

Cylinder High Register									
D7	D6	D5	D4	D3	D2	D1	D0		

5.11.6.8 Device/Head Register

The Drive/Head register is used to select the drive and head. It is also used to select LBA addressing instead of cylinder/head/sector addressing.

Table 37: Device/Head Register

1	LBA	1	DRV	HS3	HS2	HS1	HS0
D7	D6	D5	D4	D3	D2	D1	D0

Bit7: this bit is set 1.

Bit6: LBA is a flag to select either Cylinder/Head/Sector or Logical Block Address mode. When LBA=0, Cylinder/Head/Sector mode is selected. When LBA=1, Logical Block Address is selected.

Bit5: this bit is set 1.

Bit4: DRV is the drive number. When DRV=0, drive (card) 0 is selected. When DRV=1, drive (card) 1 is selected. Setting this bit to1 is obsolete in PCMCIA modes of operation.

Bit3: When operation in the Cylinder/Head/Sector mode, this is bit 3 of the head number. It is bit 27 in the Logical Block Address mode.

Bit2: When operation in the Cylinder/Head/Sector mode, this is bit 2 of the head number. It is bit 26 in the Logical Block Address mode.

Bit1: When operation in the Cylinder/Head/Sector mode, this is bit 1 of the head number. It is bit 25 in the Logical Block Address mode.

Bit0: When operation in the Cylinder/Head/Sector mode, this is bit 0 of the head number. It is bit 24 in the Logical Block Address mode.

5.11.6.9 Status Register

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These registers return the iCF4000 status when read by the host. Reading the Status register does clear a pending interrupt while reading the Auxiliary Status register does not.



BUSY	RDY	DWF	DSC	DRQ	CORR	0	ERR
D7	D6	D5	D4	D3	D2	D1	D0

Bit7: the busy bit is set when the iCF4000 has access to the command buffer and registers and the host is locked out from accessing the command register and buffer. No other bits in this register are valid when this bit set to a 1.

Bit6: RDY indicates whether the device is capable of performing iCF4000 operations. This bit is cleared at power up and remains cleared until the card is ready to accept a command.

Bit5: This bit, if set, indicates a write fault has occurred.

Bit4: This bit is set when the iCF4000 is ready.

Bit3: The Data Request is set when the iCF4000 requires that information be transferred either to or from the host through the Data register.

During the data transfer of DMA commands, the card shall not asserted DMARD unless either the BUST bit, the DRQ, or both are set to one.

Bit2: This bit is set when a Correctable data error has been encountered and the data has been corrected. This condition does not terminate a multi-sector read operation.

Bit1: This bit is always to 0.

Bit0: This bit is set when the previous command has ended in some type of error. The bits in the Error register contain additional information description the error.

5.11.6.10 Device Control Register

This register is used to control the iCf4000 interrupt request and to issue an ATA soft reset to the card. This register can be written even if the device is BUSY.

Table 39: Device Control Register

X	X	Х	Х	Х	SW Rst	-IEn	0
D7	D6	D5	D4	D3	D2	D1	D0

Bit7-3: These bits are ignored.

Bit2: This bit is set to 1 in order to force the iCF4000 to perform a Soft Reset operation. This does not change PCMCIA Card Configuration Register as a hardware Reset does. The Card remains in Reset until this bit is reset to '0'.

Bit1: the Interrupt Enable bit enables interrupts when the bit is 0. When the bit is 1, interrupt from the iCF4000 are disabled. This bit also controls the Int bit in the Configuration and Status Register. This bit is set to 0 at power on and Reset.

Bit0: This bit is ignored.

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5.11.6.11 Drive Address Register

This register is provide for compatibility with the AT disk drive interface.

Table 40: Drive Address Register

Х	-WTG	-HS3	-HS2	-HS1	-HS0	-nDS1	-nDS0
D7	D6	D5	D4	D3	D2	D1	D0

Bit7: this bit is unknown.

Bit6: this bit is – when a write operation is in progress; otherwise, it is 1.

Bit5: this bit is the negation of bit 3 in the Drive/Head register.

Bit4: this bit is the negation of bit 2 in the Drive/Head register.

Bit3: this bit is the negation of bit 1 in the Drive/Head register.

Bit2: this bit is the negation of bit 0 in the Drive/Head register.

Bit1: this bit is 0 when drive 1 is active and selected.

Bit0: this bit is 0 when the drive 0 is active and selected...

5.12 Hardware Reset(Only for Memory Card mode and I/O Card Mode)

Table 41: Timing Diagram, Hardware Reset

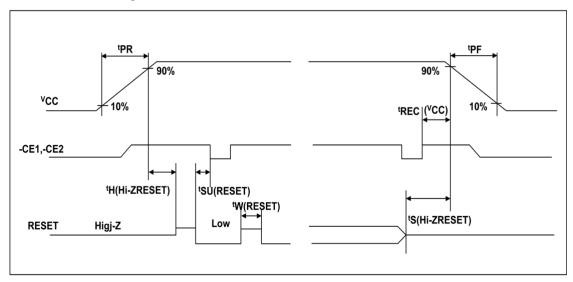
	Item	Min.	Max.	Normal	Unit
t _{SU} (RESET)	Reset Setup	20	-	-	ms
	Time				
$t_{REC}(VCC)$	-CE Recover	1	-	-	us
	Time				
t _{PR}	VCC rising up	0.1	100	-	ms
	time				
t _{PF}	VCC falling	3	300	-	ms
	down time				
t _W (RESET)	Reset pulse	10	-	-	ms
t _H (Hi-ZRESET)	width	0	-	-	
t _S (Hi-ZRESET)		0	-	_	

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Figure 18: Timing Diagram, Hardware Reset

Hardware Reset Timing



5.13 Power On Reset

When the VCC power reaches to 2.7V, the disk drive will be reset.

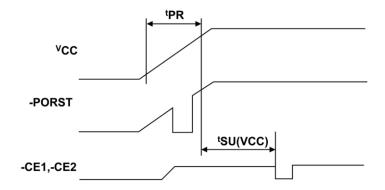
Table 42: Timing Diagram, Power On Reset

	Item	Min.	Max.	Normal	Unit	Note
t _{SU} (RESET)	-CE Setup Time	20	-	-	ms	
t _{PR}	-VCC Rising Up	0.1	100	-	ms	
	Time					



Figure 19: Timing Diagram, Power On Reset

Power on Reset Timing



5.14 Supported IDE Commands

iCF4000 supports the commands listed in Table 43.

Table 43: IDE Commands

Class	Command	Code	FR	sc	SN	CY	DH	LBA
1	Check Power Mode	98H or E5H	-	-	-	-	D	-
1	Execute Device Diagnostic	90H	-	-	-	-	D	-
1	Erase Sector(s)	C0H	-	Υ	Υ	Υ	Υ	Υ
2	Format Track	50H	-	Υ	-	Υ	Υ	Υ
1	Identify Device	ECH	-	-	-	-	D	-
1	Idle	97H or E3H	-	Υ	-	-	D	-
1	Idle immediate	95H or E1H	-	-	-	-	D	-
1	Initialize Device Parameters	91H	-	Υ	-	-	Υ	-
1	NOP	00H	-	-	-	-	D	-
1	Read Buffer	E4H	-	-	-	-	D	-
1	Read DMA	C8H	-	Υ	Υ	Υ	Υ	Υ
1	Read Long Sector	22H or 23H	-	-	Υ	Υ	Υ	Υ
1	Read Sector(s)	20H or 21H	-	Υ	Υ	Υ	Υ	Υ
1	Read Verify Sector(s)	40H or 41H	-	Υ	Υ	Υ	Υ	Υ
1	Recalibrate	1XH	-	-	-	-	D	-
1	Request Sense	03H	-	-	-	-	D	-

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1	Seek	7XH	-	-	Υ	Υ	Υ	Υ
1	Set Features	EFH	Υ	-	-	-	D	-
1	Set Multiple Mode	С6Н	-	Υ	-	-	D	-
1	Set Sleep Mode	99H or E6H	-	-	-	-	D	-
1	Standby	96H or E2H	-	-	-	-	D	-
1	Standby Immediate	94H or E0H	-	-	-	-	D	-
2	Write Buffer	E8H	-	-	-	-	D	-
2	Write DMA	CAH	-	Υ	Υ	Υ	Υ	Υ
2	Write Sector(s)	30H or 31H	-	Υ	Υ	Υ	Υ	Υ
2	Write Sector(s) without Erase	38H	-	Y	Y	Y	Υ	Υ

Defines:

FR: Feature Register

SC: Sector Count Register SN: Sector Number Register

CY: Cylinder Registers

DH: Card/Device/Head Register

LBA: LBA Block Address Mode Supported

Y: The register contains a valid parameter for this command. For Card/Device/Head Register Y means both the CompactFlash Storage Card and head parameter are used; D – only the CompactFlash Storage Card parameter is valid and not the head parameter; C – The register contains command specific data (see command description for use).

5.14.1 Check power mode – 98H or E5H

Register	7	6	5	4	3	2	1	0	
Command(7)	98h or I	98h or E5h							
C/D/H(6)	Χ			Drive	X				
Cylinder High(5)	Χ								
Cylinder Low(4)	Χ	X							
Sector Number(3)	Χ								
Sector Count(2)	Χ								
Feature(1)	Х								

This command checks the power mode:

If the CompactFlash Storage is in, going to, or recovering from the sleep mode, the CompactFlash Storage Card sets BSY, sets the Sector Count Register to 00h, clears BSY and generates an interrupt.

If the compactFlash Storage Card is in idle mode, the CompactFlash Storage Card



sets BSY, sets the Sector Count Register to FFh, clears BSY and generates an interrupt.

5.14.2 Execute Device Diagnostic – 90H

Register	7	6	5	4	3	2	1	0
Command(7)	90h							
C/D/H(6)	Χ			Drive	Χ			
Cylinder High(5)	Χ							
Cylinder Low(4)	Χ							
Sector Number(3)	Χ							
Sector Count(2)	Χ							
Feature(1)	Χ							

This command performs the internal diagnostic tests implemented by the CompactFlash Storage Card. When the diagnostic command is issued in a PCMCIA configuration mode, this command runs only on the CompactFlash Storage Card that is addressed by the Drive/Head register. This is because PCMCIA card interface does not allow for direct inter-drive communication (such as the ATA PDIAG and DASP signals). When the diagnostic command is issued in the True IDE Mode, the Drive bit is ignored and the diagnostic command is executed by both the Master and the Slave with the Master responding with status for both devices. The Diagnostic codes are shown in Table 44. Diagnostic Codes are returned in the Error Register at the end of the command.

Table 44: Diagnostic

Code	Error Type
01h	No Error Detected
02h	Formatter Device Error
03h	Sector Buffer Error
04h	ECC Circuitry Error
05h	Controller Microprocessor Error
8Xh	Slave Error in True IDE Mode

5.14.3 Erase Sector(s) - C0H

Register	7	6	5	4	3	2	1	0		
Command(7)	C0h	COh								
C/D/H(6)	1	LBA	1	Drive	Head (LBA 27-24)					
Cylinder High(5)	Cylinde	Cylinder High (LBA 23-16)								



Cylinder Low(4)	Cylinder Low (LBA 15-8)
Sector Number(3)	Sector Number (LBA 7-0)
Sector Count(2)	Sector Count
Feature(1)	Х

This command is used to pre-erase and condition data sectors in advance of a Write without Erase or Write Multiple without Erase command. There is no data transfer associated with this command but a Write Fault error status can occur.

5.14.4 Format Track - 50H

Register	7	6	5	4	3	2	1	0			
Command(7)	50h	50h									
C/D/H(6)	1	1 LBA 1 Drive Head (LBA 27-24)									
Cylinder High(5)	Cylinde	Cylinder High (LBA 23-16)									
Cylinder Low(4)	Cylinde	r Low (LE	BA 15-8)								
Sector Number(3)	X (LBA	7-0)									
Sector Count(2)	Count(L	Count(LBA mode only)									
Feature(1)	Χ	X									

This command writes the desired head and cylinder of the selected drive with a vendor unique data pattern (typically FFh or 00h). To remain host backward compatible, the CompactFlash Storage Card expects a sector buffer of data from the host to follow the command with the same protocol as the Write Sector(s) command although the information in the buffer is not used by the CompactFlash Storage Card. If LBA=1 then the number of sectors to format is taken from the Sec Cnt register (0=256). The use of this command is not recommended.

5.14.5 Identify Device - ECH

Register	7	6	5	4	3	2	1	0
Command(7)	ECh							
C/D/H(6)	Х	Х	Х	Drive	Х			
Cylinder High(5)	Χ							
Cylinder Low(4)	Χ							
Sector Number(3)	Χ							
Sector Count(2)	Χ							
Feature(1)	Χ							

The Identify Device command enables the host to receive parameter information from the CompactFlash Storage Card. This command has the same protocol as the Read Sector(s) command. The parameter words in the buffer have the arrangement and



meanings defined in Table 45. All reserved bits or words are zero. Hosts should not depend in Obsolete words in Identify Device containing 0. Table 45 specifies each filed in the data returned by the Identify Device Command. In Table 45, X indicates a numeric nibble vale specific to the card and aaaa indicates an ASCII string specific to the particular drive.

Table 45: IDENTIFY DEVICE information

Word	Description	Value
	General Configuration	
	Bit 15 0=ATA device	
	Bit 14:8 Retired	
0	Bit 7:6 Obsolete	045Ah
0	Bit 5:3 Retired	043AII
	Bit 2 Response incomplete	
	Bit 1 Retired	
	Bit 0 reserved	
1	Number of logical cylinders	XXXXh
2	Specific configuration	0000h
3	Number of logical heads	16
4-5	Retired	0000h
6	Number of logical sectors per logical track	63
7-8	Number of sectors per card	XXXXh
9	Retired	0000h
10-19	Serial number in 20 ASCII	aaa
20-21	Retired	0002h 0002h
22	Obsolete	0004h
23-26	Firmware revision in 8 ASCII	aaaa
27-46	Model number in 40 ASCII	aaaa
	15-8: 80	
	7-0: 00h Reserved	
47	01h-FFh: Maximum number of sectors that shall be	8002h
	transferred per DRQ data block on READ/WRITE Multiple	
	commands	
	Trusted Computing feature set options	
48	15 shall be cleared to zero	0000h
40	14 shall be set to one	000011
	13:1 Reserved for the Trusted Computing Group	



	0 0 = Trusted Computing feature set is not supported		
	Capabilities		
	15-14: Reserved for the IDENTIFY PACKET DEVICE command.		
	13: 1=Standby timer values as specified in this standard are		
	supported		
	0:Standby timer values shall be managed by the device		
40	12: Reserved for the IDENTIFY PACKET DEVICE command	05004	
49	11: 1=IORDY supported	0F00h	
	0=IORDY may be disabled		
	10 1: IORDY may be disabled		
	9 1=LBA supported		
	8 1=DMA supported.		
	7-0 Retired		
	Capabilities		
	15: Shell be cleared to zero		
50	14: Shall be set to one	00001	
50	13:2 Reserved	0000h	
	1 Obsolete		
	0 0		
51	PIO data transfer cycle timing mode	0200h	
52	Obsolete	0000h	
	15 Free-fall control Sensitivity		
	00h: Vendor's recommended setting		
53	7:3 Reserved	0007h	
33	2: 1=the fields reported in word 88 are valid	000711	
	1: 1=the fields reported in words (70:64) are valid		
	0: Obsolete		
54	Number of current logical cylinders	XXXXh	
55	Number of current logical heads	XXXXh	
56	Number of current logical sectors per logical track	XXXXh	
57-58	Current capacity in sectors	XXXXh	
	15:9 Reserved		
	8 0:Multiple sector setting is invalid		
59	7:0 Current setting for number of logical sectors that shall be	0102h	
	transferred per DRQ data block on READ/WRITE Multi		
	commands		
60-61	Total number of user address sectors(DWord)	XXXXXXXXh	
62	Obsolete	0000h	



63	Multi-word DMA transfer(Not support)	0007h
64	15-8 Reserved	00001
64	7-0 PIO modes supported	0003h
	Minimum Multiword DMA transfer cycle time per word	
65	15-0 Cycle time in nanoseconds	0078h
	In PCMCIA mode this value shall be 0h	
	Manufacturer's recommended Multiword DMA transfer cycle time	
66	per word	0078h
	15-0 Cycle time in nanoseconds	667.6.1
	In PCMCIA mode this value shall be 0h	
67	Minimum PIO transfer cycle time without flow control	0078h
· ·	15-0 Cycle time in nanoseconds	00.0
68	Minimum PIO transfer cycle time with IORDY flow control	0078h
	15-0 Cycle time in nanoseconds	
69-74	Reserved	0000h
75	No DMA QUEUED command supports	0000h
	Serial ATA Capabilities	
	15:11 Reserved for Serial ATA	
	10 1= Supports Phy Event Counters	
	9 1= Supports receipt of host initiated power management	
76	Requests	0000h
	8 0= No Support native Command Queuing	
	7:3 Reserved for future SATA signaling speed grades	
	2 1=Supports SATA Gen2 Signaling Speed (3.0Gb/s)	
	1 1=Support SATA Gen1 Signaling Speed (1.5Gb/s)	
	0 Shall be cleared to zero	
77	Reserved for Serial ATA	0000h
	Serial ATA features supported	
	15:7 Reserved for Serial ATA	
78	6 0=Device not supports Software Settings Preservation	
	5 Reserved for Serial ATA	
	4 0= Device not supports in-order data delivery	0000h
	3 0= Device not supports initiating power management	
	2 0= Device not supports DMA Setup auto-activation	
	1 0= Device not supports non-zero buffer offsets	
	0 Shall be cleared to zero	
79	Serial ATA feature enabled	0000h
	15:7 Reserved for Serial ATA	



	6 0=Software Settings Preservation not enabled	
	5 0=Reserved for Serial ATA	
	4 0= In-order data delivery not enabled	
	3 0= Device initiated power management not enabled	
	2 0= DMA setup auto-activation not enabled	
	1 0= Non-zero buffer offsets not enabled	
	0 Shall be cleared to zero	
80-81	ATA Version support (ATA8-ACS)	0020 0000h
	Command and feature sets supported	
	15 0 = Obsolete	
	14 0 = NOP Command not supported	
	13 0 = READ BUFFER Command not supported	
	12 0 = WRITE BUFFER Command not supported	
	11 0 = Obsolete	
	10 0 = Host Protected Area Feature Set not supported	
	9 0 = DEVICE RESET Command not supported	
82	8 0 = SERVICE Interrupt not supported	700Ah
	7 0 = RELEASE Interrupt not supported	
	6 1 = Look-ahead supported	
	5 1 = Write Cache supported	
	4 0 = indicate that the PACKET feature set is not supported	
	3 1 = mandatory Power Management Feature Set supported	
	2 0 = Obsolete	
	1 0 = Security Mode Feature Set not supported	
	0 1 = SMART Feature Set supported	
	Command and feature sets supported	
	15 Shall be cleared to zero	
	14 Shall be set to one	
	13 0 = FLUSH CACHE EXT Command not supported	
	12 1 = mandatory FLUSH CACHE Command supported	
	11 0 = Device Configuration Overlay feature set not supported	
83	10 0 = 48-Bit Address feature set not supported	5004h
	9 0 = Automatic Acoustic Management feature set not	
	supported	
	8 0 = SET MAX security extension not supported	
	7 0 = See Address Offset Reserved Area Boot, INCITS	
	TR27:2001	
	6 0 = SET FEATURES subcommand not required to spin-up	



	after power-up	
	5 0 = Power-Up in Standby feature set supported	
	4 0 = Removable Media Status Notification feature set not	
	supported	
	3 0 = Advanced Power Management feature set not	
	supported	
	2 0 = CFA feature set not supported	
	1 0 = READ/WRITE DMA QUEUED not supported	
	0 1 = DOWNLOAD MICROCODE Command supported	
	Command Set/Feature Supported Extension	
	15 Shall be cleared to zero	
	14 Shall be set to one	
	13-6 Reserved	
	5 0 = General Purpose Logging feature set not supported	
84	4 reserved	4000h
	3 0 = Media Card Pass Through Command feature set not	
	supported	
	2 0 = Media Serial Number not supported	
	1 0 = SMART self-test not supported	
	0 1 = SMART Error Logging not supported	
	Command and feature sets supported or enabled	
	15 0 = Obsolete	
	14 0 = NOP Command not enabled	
	13 0 = READ BUFFER Command not enabled	
	12 0 = WRITE BUFFER Command not enabled	
	11 Obsolete	
	10 0 = Host Protected Area feature set not enabled	
	9 0 = DEVICE RESET Command not enabled	
	8 0 = SERVICE Interrupt not enabled	
85	7 0 = RELEASE Interrupt not enabled	7008
	6 0 = Look-ahead not enabled	
	5 0 = Write Cache not enabled	
	4 Shall be cleared to zero to indicate that the PACKET	
	Command feature set is not supported.	
	3 1 = Power Management Feature Set enabled	
	2 0 = Removable Media feature set not enabled	
	1 0 = Security Mode Feature Set not enabled	
	0 0 = SMART Feature Set not enabled	



	Command set/feature enabled	
	15-14 0 = Reserved	
	13 0 = FLUSH CACHE EXT Command not supported	
	12 1 = FLUSH CACHE Command supported	
	11 0 = Device Configuration Overlay not supported	
	10 0 = 48-Bit Address features set not supported	
	9 0 = Automatic Acoustic Management feature set not enabled	
	8 0 = SET MAX security extension not enabled by SET MAX	
	SETPASSWORD	
86	7 0 = Reserved	1004h
	6 0 = SET FEATURES subcommand required to spin-up after	
	power-up not enabled	
	5 0 = Power-Up in Standby feature set not enabled	
	4 0 = Obsolete	
	3 1 = Advanced Power Management feature set enabled	
	2 0 = CFA feature set not supported	
	1 0 = READ/WRITE DMA QUEUED Command not supported	
	0 1 = DOWNLOAD MICROCODE Command supported	
	Command and feature sets supported or enabled	
	15 Shall be cleared to zero	
	14 Shall be set to one	
	13 1 = IDLE IMMEDIATE with UNLOAD FEATURE supported	
	12 0 = Reserved for Technical Report, INCITS TR-37-2004	
	11 0 = Reserved for Technical Report, INCITS TR-37-2004	
	10:9 0 = Obsolete	
	8 0 = 64-Bit World Wide Name not supported	
	7 0 = WRITE DMA QUEUED FUA EXT Command not	
87	supported	4000h
	6 0 = WRITE DMA FUA EXT and WRITE MULTIPLE FUA EXT	
	commands not supported	
	5 0 = General Purpose Logging feature set not supported	
	4 0 = Obsolete	
	3 0 = Media Card Pass Through Command feature set not	
	supported	
	2 0 = Media Serial Number is not valid	
	1 0 = SMART Self-Test not supported	
	0 0 = SMART Error-Logging not supported	
88	Ultra DMA modes	X01Fh



	15 Reserved	
	14 0 = Ultra DMA mode 6 is not supported	
	13 1= Ultra DMA mode 5 is selected	
	0= Ultra DMA mode 5 is not selected	
	12 1= Ultra DMA mode 4 is selected	
	0= Ultra DMA mode 4 is not selected	
	11 1= Ultra DMA mode 3 is selected	
	0= Ultra DMA mode 3 is not selected	
	10 1= Ultra DMA mode 2 is selected	
	0= Ultra DMA mode 2 is not selected	
	9 1= Ultra DMA mode 1 is selected	
	0= Ultra DMA mode 1 is not selected	
	8 1= Ultra DMA mode 0 is selected	
	0= Ultra DMA mode 0 is not selected	
	7 Reserved	
	6 0= Ultra DMA mode 6 is not supported	
	5 1= Ultra DMA mode 5 and below are supported	
	4 1= Ultra DMA mode 4 and below are supported	
	3 1= Ultra DMA mode 3 and below are supported	
	2 1= Ultra DMA mode 2 and below are supported	
	1 1= Ultra DMA mode 1 and below are supported	
	0 1= Ultra DMA mode 0 is supported	
	Time required for Normal Erase mode SECURITY ERASE UNIT	
89	command	0000h
	Time required for Enhanced erase mode SECURITY ERASE	
90	UNIT command	0000h
91	Current advanced power management level value	0000h
92	Master Password Identifier	0000h
	Hardware reset result	
93		XXXXh
	Current automatic acoustic management value	
94	15:8 Vendor's recommended acoustic management value.	0000h
	7:0 Current automatic acoustic management value.	
95-126	Reserved	0000h
127	Obsolete	0000h
.21		000011
120	Security Status	0000h
128	15:9 Reserved	0000h
	8 Security level 0 = high, 1 = Maximum	



	7:6 Reserved	
	5 1= Enhanced security erase supported	
	4 1= Security count expired	
	3 0= Security frozen.	
	2 0 = Security not locked	
	1 0= Security not enabled	
	0 0= Security not supported	
129-159	Vendor specific	0000h
160	CFA power mode 1	0000h
161-175	Reserved	0000h
176-205	Current media serial number	0000h
206-254	Reserved	0000h
	Integrity word	
255	15:8 Check Sum	XXXXh
	7:0 Signature	

5.14.6 Idle -97H or E3H

Register	7	6	5	4	3	2	1	0
Command(7)	97h or l	97h or E3h						
C/D/H(6)	Χ	X Drive X						
Cylinder High(5)	Χ	X						
Cylinder Low(4)	Χ	X						
Sector Number(3)	Χ	X						
Sector Count(2)	Timer C	Timer Count (5 msec increments)						
Feature(1)	Χ							

This command causes the CompactFlash Storage Card to set BSY, enter the IDLE mode, clear BSY and generate an interrupt. If the sector count is non-zero, it is interpreted as a timer count with each count being 5 milliseconds and the automatic power down mode is enabled. If the sector count is zero, the automatic power down mode is disabled. Note that this time base (5 msec) is different from the ATA sepecification.

5.14.7 Idle immediate - 95H or E1H

Register	7	6	5	4	3	2	1	0
Command(7)	95h or I	95h or E1h						
C/D/H(6)	Х			Drive	Χ			
Cylinder High(5)	Χ							



Cylinder Low(4)	X
Sector Number(3)	X
Sector Count(2)	X
Feature(1)	X

This command causes the CompactFlash Storage Card to set BSY, enter the IDLE mode, clear BSY and generate an interrupt.

5.14.8 Initialize Device Parameters - 91H

Register	7	6	5	4	3	2	1	0	
Command(7)	91h	91h							
C/D/H(6)	Χ	X O X Drive Max Head (no. of heads-1)						1)	
Cylinder High(5)	Х	X							
Cylinder Low(4)	Χ								
Sector Number(3)	Χ								
Sector Count(2)	Numbe	Number of sectors							
Feature(1)	X								

This command enables the host to set the number of sectors per track and the number of heads per cylinder. Only the Sector Count and the Card/Device/Head registers are used by this command.

5.14.9 NOP - 00H

Register	7	6	5	4	3	2	1	0
Command(7)	00h							
C/D/H(6)	Х			Drive	Х			
Cylinder High(5)	Х							
Cylinder Low(4)	Х							
Sector Number(3)	Х							
Sector Count(2)	Х							
Feature(1)	Х							

This command always fails with the CompactFlash Storage Card returning command aborted.

5.14.10 Read Buffer - E4H

Register	7	6	5	4	3	2	1	0
Command(7)	E4h							
C/D/H(6)	Х			Drive	Х			
Cylinder High(5)	Х							



Cylinder Low(4)	X
Sector Number(3)	X
Sector Count(2)	X
Feature(1)	X

The Read Buffer command enables the host to read the current contents of the CompactFlash Storage Card's sector buffer. This command has the same protocol as the Read Sector(s) command.

5.14.11 Read DMA - C8H

Register	7	6	5	4	3	2	1	0
Command(7)	C8	C8						
C/D/H(6)	1	1 LBA 1 Drive Head (LBA 27-24)						
Cylinder High(5)	Cylinde	Cylinder High (LBA 23-16						
Cylinder Low(4)	Cylinde	r Low (LE	3A 15-8					
Sector Number(3)	Sector I	Numbe(L	BA 7-0					
Sector Count(2)	Sector	Sector Count						
Feature(1)	Χ	X						

This command uses DMA mode to read from 1 to 256 sectors as specified in the Sector Count register. A sector count of 0 request 256 sectors. The transfer begins at he sector specified in the Sector Number Register. When this command is issued the CompactFlash Storage Card sets BSY, puts all or part of the sector of data in the buffer. The Card is then permitted, although not required, to set DRQ, cleat BSY. The Card asserts DMAREQ while data is available to be transferred. The Card asserts DMAREQ while data is available to be transferred. The host then reads the (512 & sector –count) bytes of data from the Card using DMA. While DMAREQ is asserted by the Card, the Host asserts –DMACK while it is ready to transfer data by DMA and asserts –IORD once for each 16 bit word to be transferred to the Host.

Interrupts are not generated on every sector, but upon completion of the transfer of the entire number of sectors to be transferred or upon the occurrence of an unrecoverable error.

At command completion, the Command Block Registers contain the cylinder, head and sector number of the last sector read. If an error occurs, the read terminates at the sector where the error occurred. The command Block Registers contain the cylinder, head, and sector number of the sector where the occurred. The amount of data transferred is indeterminate.

When a Read DMA command is received by the Card and 8 bit transfer mode has been enabled by the Set Features command, the Card shall return the Aborted error.



5.14.12 Read Long Sector - 22H or 23H

Register	7	6	5	4	3	2	1	0
Command(7)	22h or 2	22h or 23h						
C/D/H(6)	1	1 LBA 1 Drive Head (LBA 27-24)						
Cylinder High(5)	Cylinde	Cylinder High (LBA 23-16)						
Cylinder Low(4)	Cylinde	r Low (LE	BA 15-8)					
Sector Number(3)	Sector I	Number ((LBA 7-0)					
Sector Count(2)	Χ	X						
Feature(1)	X							

The Read Long command performs similarly to the Read Sector(s) command except that is returns 516 bytes of data instead of 512 bytes. During a Read Long command, the CompactFlash Storage Card does not check the ECC bytes to determine if there consists of 512 bytes of data transferred in word mode followed by 4 bytes of ECC data transferred in byte mode. This command has the same protocol as the Read Sector(s) command. Use of this command is not recommended.

5.14.13 Read Sector(s) - 20H or 21H

Register	7	6	5	4	3	2	1	0
Command(7)	20h or 2	20h or 21h						
C/D/H(6)	1	1 LBA 1 Drive Head (LBA 27-24)						
Cylinder High(5)	Cylinde	Cylinder High (LBA 23-16)						
Cylinder Low(4)	Cylinde	r Low (LE	3A 15-8)					
Sector Number(3)	Sector I	Number ((LBA 7-0))				
Sector Count(2)	Sector	Sector Count						
Feature(1)	Х	X						

This command reads from 1 to 256 sectors as specified in the Sector Count Register. A sector count of 0 requests 256 sectors. The transfer begins at the sector specified in the Sector Number Register. When this command is issued and after each sector of data (except the last one) has buffer, sets DRQ, cleats BSY, and generates an interrupt. The host then reads the 512 bytes of data from the buffer.

At command completion, the Command Block Registers contain the cylinder, head and sector number of the last sector read. If an error occurs, the read terminates at the sector where the error occurred. The command Block Registers contain the cylinder head, and sector number of the sector 2where the error occurred. The flawed data is pending in the sector buffer.



5.14.14 Read Verify Sector(s) - 40H or 41H

Register	7	6	5	4	3	2	1	0
Command(7)	40h or 4	40h or 41h						
C/D/H(6)	1	1 LBA 1 Drive Head (LBA 27-24)						
Cylinder High(5)	Cylinde	Cylinder High (LBA 23-16)						
Cylinder Low(4)	Cylinde	r Low (LE	3A 15-8)					
Sector Number(3)	Sector I	Number ((LBA 7-0))				
Sector Count(2)	Sector	Sector Count						
Feature(1)	Х	X						

This command is identical to the Read Sectors command, except that DRQ is never set and no data is transferred to the host. When the command is accepted, the CompactFlash Storage Card sets BSY.

When the requested sectors have been verified, the CompactFlash Storage Card clears BSY and generates an interrupt. Upon command completion, the Command Block Registers contain the cylinder, head, and sector number of the last sector verified.

If an error occurs, the Read Verify Command terminates at the sector where the error occurs. The Command Block Registers contain the cylinder, head and sector number of the sector where the error occurred. The Sector Count Register contains the number of sectors not yet verified.

5.14.15 Recalibrate - 1XH

Register	7	6	5	4	3	2	1	0	
Command(7)	1Xh	1Xh							
C/D/H(6)	1	LBA	1	Drive	Х				
Cylinder High(5)	Х								
Cylinder Low(4)	Х								
Sector Number(3)	Х								
Sector Count(2)	Х								
Feature(1)	Х								

This command is effectively a NOP command to the CompactFlash Storage Card and is provided for compatibility.

5.14.16 Request Sense - 03H

Register	7	6	5	4	3	2	1	0
Command(7)	03h	03h						
C/D/H(6)	1	LBA	1	Drive	Χ			



Cylinder High(5)	X
Cylinder Low(4)	X
Sector Number(3)	X
Sector Count(2)	X
Feature(1)	X

This command requests extended error information for the previous command. Table46 defines the valid extended error codes for the CompactFlash Storage Card Series product. The extended error code is returned to the host in the Error Register.

Table 46: Extended Error Codes

Extended Error Code	Description					
00h	No Error Detected					
01h	Self Test OK					
09h	Miscellaneous Error					
20h	Invalid Command					
21h	Invalid Address					
2Fh	Address Overflow					
35h, 36h	Supply or generated Voltage Out of					
	Tolerance					
11h	Uncorrected ECC Error					
18h	Corrected ECC Error					
05h,30-34h, 37h, 3Eh	Self Test or Diagnostic Falied					
10h, 14h	ID Not Found					
3Ah	Spare Sectors Exhausted					
1Fh	Data Transfer Error/Aborted Command					
0Ch, 38h,3Bh,3Ch,3Fh	Corrupted Media Format					
03h	Write/ Erase Failed					
22h	Power Level 1 Disabled					

5.14.17 Seek - 7XH

Register	7	6	5	4	3	2	1	0
Command(7)	7Xh	rXh						
C/D/H(6)	1	LBA	1	Drive	Head (LBA 27-24)			
Cylinder High(5)	Cylinde	Cylinder High (LBA 23-16)						
Cylinder Low(4)	Cylinde	r Low (LE	3A 15-8)					
Sector Number(3)	X (LBA	X (LBA 7-0)						
Sector Count(2)	Χ	x						



Feature	e(1)	X

This command is effectively a NOP command to the CompactFlash Storage Card although it does perform a range check of cylinder and head or LBA address and returns an error if the address is out of range.

5.14.18 Set Features – EFH

Register	7	6	5	4	3	2	1	0	
Command(7)	EFh								
C/D/H(6)	Χ			Drive	X				
Cylinder High(5)	Χ	(
Cylinder Low(4)	Χ	X							
Sector Number(3)	Χ								
Sector Count(2)	Config	Config							
Feature(1)	Feature								

This command is used by the host to establish or select certain features. If any subcommand input value is not supported or is invalid, the CompactFlash Storage Card shall return command aborted. Table 47: Feature Supported defines all features that are supported.

Table 47: Feature Supported

Feature	Operation
02h	Enable Write Cache.
03h	Set transfer mode based on value in Sector Counter register.
55h	Disable Read Look Ahead.
66h	Disable Power on Reset (POR) establishment of defaults at Soft
	reset.
82h	Disable Write cache.
9Ah	Set the host current source capability. Allows tradeoff between
	current drawn and read/write speed.
AAh	Enable Read Look Ahead.
BBh	4 Bytes of data apply on Read/Write Long commands.
CCh	Enable Power on Reset (POR) establishment of defaults at Soft
	Reset.

5.14.19 Set Multiple Mode - C6H



Register	7	6	5	4	3	2	1	0	
Command(7)	C6h	C6h							
C/D/H(6)	Х			Drive	Х				
Cylinder High(5)	Х	(
Cylinder Low(4)	Х	X							
Sector Number(3)	Х								
Sector Count(2)	Sector	Sector Count							
Feature(1)	Х								

This command enables the CompactFlash Storage Card to perform Read and Write Multiple operations and establishes the block count for these commands. The Sector Count Register is loaded with the number of sectors per block. Upon receipt of the command, the CompactFlash Storage Card sets BSY to 1 and checks the Sector Count Register.

If the Sector Count Register contains a valid value and the block count is supported, the value is loaded and execution is enabled for all subsequent Read Multiple and Write Multiple commands.

If the Sector Count Register contains 0 when the command is issued, Read and Write Multiple commands are disabled. At power on, or after a hardware or (unless disabled by a Set Feature command) software reset, the default mode is Read and Write multiple disabled.

5.14.20 Set Sleep Mode - 99H or E6H

Register	7	6	5	4	3	2	1	0	
Command(7)	99h or I	99h or E6h							
C/D/H(6)	Χ			Drive	X				
Cylinder High(5)	Χ								
Cylinder Low(4)	Χ	Κ							
Sector Number(3)	Χ								
Sector Count(2)	Х								
Feature(1)	Х								

This command causes the CompactFlash Storage Card to set BSY, enter the Sleep mode, clear BSY and generate an interrupt. Recovery from sleep mode is accomplished by simply issuing another command (a reset is permitted but not required). Sleep mode is also entered when internal timers expire so the host does not need to issue this command except when it wishes to enter Sleep mode immediately. The default value for the timer is 5 milliseconds.



5.14.21 Standby - 96H or E2H

Register	7	6	5	4	3	2	1	0	
Command(7)	96h or I	≣2h							
C/D/H(6)	Χ			Drive	X				
Cylinder High(5)	Χ								
Cylinder Low(4)	Χ	X							
Sector Number(3)	Χ								
Sector Count(2)	Χ	X							
Feature(1)	Χ								

This command causes the CompactFlash Storage Card to set BSY, enter the Sleep mode, cleat BSY and return interrupt immediately. Recovery from sleep mode is accomplished by simply issuing another command (a reset is not required).

5.14.22 Standby Immediate - 94H or E0H

Register	7	6	5	4	3	2	1	0
Command(7)	94h or I	Ξ 0h						
C/D/H(6)	Χ			Drive	Χ			
Cylinder High(5)	Χ							
Cylinder Low(4)	Χ							
Sector Number(3)	Χ							
Sector Count(2)	Χ							
Feature(1)	Χ							

This command causes the CompactFlash Storage Card to set BSY, enter the Sleep mode, clear BSY and return the interrupt immediately. Recovery from sleep mode is accomplished by simply issuing another command (a reset is not required).

5.14.23 Write Buffer - E8H

Register	7	6	5	4	3	2	1	0
Command(7)	E8h							
C/D/H(6)	Χ			Drive	Х			
Cylinder High(5)	Χ							
Cylinder Low(4)	Χ							
Sector Number(3)	Χ							
Sector Count(2)	Χ							
Feature(1)	Χ							

The Write Buffer command enables the host to overwrite contents of the CompactFlash Storage Card's sector buffer with any data pattern desired. This



command has the same protocol as the Write Sector(s) command and transfer 512 bytes.

5.14.24 Write DMA - CAH

Register	7	6	5	4	3	2	1	0
Command(7)	CAh	CAh						
C/D/H(6)	1	LBA 1 Drive Head (LBA 27-24)						
Cylinder High(5)	Cylinde	Cylinder High (LBA 23-16)						
Cylinder Low(4)	Cylinde	Cylinder Low(LBA 15-8)						
Sector Number(3)	Sector I	Number ((LBA 7-0)					
Sector Count(2)	Sector (Sector Count						
Feature(1)	Х	X						

This command uses DMA mode to write from 1 to 256 sectors as specified in the Sector Count register. A sector count of 0 requests 256 sectors. The transfer begins at the sector specified in the Sector Number Register. When this command is issued the CompactFlash Storage Card sets BSY, puts all or part of the sector of data in the buffer. The Card is then permitted, although not required, to set DRQ, clear BSY. The Card asserts DMAREQ while data is available to be transferred. The host then writes the (512*sector count) bytes of data to the Card using DMA. While DMAREQ is asserted by the Card, the host asserts -DMACK while it is ready to transfer data by DMA and asserts –IOWR once for each 16 bit word to be transferred from the Host. Interrupts are not generated on every sector, but upon completion of the transfer of the entire number of sectors to be transferred or upon the occurrence of an unrecovertable error. At command completion, the Command Block Registers contain the cylinder, head and sector number of the last sector read. If an error occurs, the read terminates at the sector where the error occurred. The Command Block Registers contain the cylinder, head and sector number of the sector where the error occurred. The amount of data transferred is indeterminate. When a write DMA command is received by the Card and 8 bit transfer mode has been enabled by the Set Features command, the Card shall return the Aborted error.

5.14.25 Write Sector(s) - 30H or 31H

Register	7	6	5	4	3	2	1	0
Command(7)	30h or 3	0h or 31h						
C/D/H(6)	1	LBA	1	Drive	e Head(LBA 27-24)			
Cylinder High(5)	Cylinde	Cylinder High (LBA 23-16)						



Cylinder Low(4)	Cylinder Low (LBA 15-8)
Sector Number(3)	Sector Number (LBA 7-0)
Sector Count(2)	Sector Count
Feature(1)	X

This command writes from 1 to 256 sectors as specified in the Sector Count Register. A sector count of zero requests 256 sectors. The transfer begins at the sector specified in the Sector Number Register. When this command is accepted, the CompactFlash Storage Card sets BST, then sets DRQ and clears BSDY, then waits for the host to fill the sector buffer with the data to be written. No interrupt is generated to start the first host transfer operation. No data should be transferred by the host until BSY has been cleared by the host.

For multiple sectors, after the first sector of data is in the buffer, BSY shall be set and DRQ shall be cleared. After the next buffer is ready for data, BSY is cleared, DRQ is set and an interrupt is generated. When the final sector of data is transferred, BSY is set and DRQ is cleared. It shall remain in this state until the command is completed at which time BSY is cleared and an interrupt is generated. If an error occurs during a write of more than one sector, writing terminates at the sector where the error occurs. The Command Block Registers contain the cylinder, head and sector number of the sector where the error occurred. The host may then read the command block to determine what error has occurred, and on which sector.



5.15 Device Parameters

iCF4000 device parameters are listed in Table 48.

Table 48: Device parameters

Capacity	Cylinders	Heads	Sectors	Capacity(MB)	LBA	
128MB	497	16	32	124.25	254464	
256MB	984	16	32	246	503808	
512MB	1001	16	63	492.68	1009008	
1GB	2002	16	63	985.36	2018016	
2GB	4003	16	63	1970.23	4035024	
4GB	8006	16	63	3940.45	8070048	
8GB	16000	16	63	7875	16128000	
16GB	16383	16	63	16025.62	32153184	
32GB	16384	16	63	31411.89	64331568	



6. InnoDisk Part Number Rule

CODE	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	
	D	С	1	M	-	5	1	2	D	3	1	С	X	S	R	-	Custo	
Description	cription Disk CF4000 - Capacity						С	Category Operation Temp. Internal Control - Customized Code										
	Defi								finit	ion								
Code 1 st (Disk)									Code 13 th (Internal Control Code)									
D : Disk								1:	1: 1 st PCB version, default setting									
Code 2 nd ~ 4 th (Form Factor)									3:	3: Removable Mode +UltraDMA								
C1M : CF, Type I, InnoLite iCF									4:	4: Preformat, Fixed Mode + PIO Mode 4								
C1S : CF Write Protect									5:	Pre-fo	rmatt	ed (iCF4000	only) +	UltraE	DMA 4			
									6:	6: Pre-formatted + Removable (iCF4000 only)+UltraDMA 4								
	Code 6 th ~8 th (Capacity)									Fixed	Mode	+ PIO Mod	e 4					
128: 128MB	128:128MB									8: Fixed Mode + MwDMA Mode 2								
256: 256MB	256: 256MB									Remo	vable	Mode + PIC	O Mode 4	-				
512:512MB																		
01G:1GB																		
02G:2GB	02G : 2GB									Code 14 th (Channel of data transfer)								
04G : 4GB									S:	S: Single Channel								
08G : 8GB								D:	D: Dual Channel									
16G: 16GB																		
32G : 32GB									Code 15 th									
									R:	new o	device	parameter(from 128	MB to	8GB)			
Code 9 th ~ 11 th (Series)							T:	T: Micron SLC (from 16GB to 32GB)										
D31: iCF 400	0																	
Code 12 th (Operation Temperature)											41	L						
C : Standard Grade (0 ~ +70 °C)								Code 17 th										
W: Industrial	Grad	е							С	ustomi	zed co	ode						
									-									
									+									
									+									
									+									





宜鼎國際股份有限公司

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RoHS 自我宣告書(RoHS Declaration of Conformity)

一、 宜鼎國際股份有限公司(以下稱本公司)特此保證售予貴公司之所有產品,皆 符合歐盟 2002/95/EC 關於 RoHS 之規範要求。

InnoDisk Corporation declares that all products sold to the company, are complied with European Union RoHS Directive (2002/95/EC) requirement

二、 本公司同意因本保證書或與本保證書相關事宜有所爭議時,雙方宜友好協商, 達成協議。

InnoDisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.

Name of hazardous substance	Limited of RoHS ppm (mg/kg)
Cd	< 100 ppm
Pb	< 1000 ppm
Hg	< 1000 ppm
Chromium VI(Cr+6)	< 1000 ppm
Polybromodiphenyl ether (PBDE)	< 1000 ppm
Polybrominated Biphenyls (PBB)	< 1000 ppm

立保證書人

Company name 公司名稱: InnoDisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人: Richard Lee 李鐘亮

Company Representative Title 公司代表人職稱:__Chairman 董事長

Date 日期: 2011 / 10 / 20



(小章)



(Company Stamp/公司章)